SSD1680

Product Preview

176 Source x 296 Gate Red/Black/White Active Matrix EPD Display Driver with Controller

This document contains information on a product under development. Solomon Systech reserves the right to change or discontinue this product without notice.



Appendix: IC Revision history of SSD1680 Specification

| Version | Change Items | Effective Date |
|---------|--|----------------|
| 0.10 | Initial Release | 28-Feb-19 |
| 0.11 | Updated Feature list | 02-Apr-19 |
| 0.12 | Updated AC Characteristics Updated Component list | 21-May-19 |
| 0.13 | Updated Component list | 24-May-19 |
| 0.14 | Updated Component list, removed case size for C0 and C1. | 5-Jun-19 |

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1 GENERAL DESCRIPTION

SSD1680 is an Active Matrix EPD display driver with controller for Red/Black/White EPD displays.

It consists of 176 source outputs, 296 gate outputs, 1 VCOM and 1VBD (for border), which can support displays with resolution up to 176x 296. In addition, SSD1680 has a cascade mode which provides two-chip solutions for displays with higher resolution.

In the SSD1680, data and commands are sent from MCU through hardware selectable serial peripheral interface. It has embedded booster, regulator and oscillator which is suitable for EPD display applications.

2 FEATURES

- Design for dot matrix type active matrix EPD display, support Red/Black/White color
- Resolution: 176 source outputs, 296 gate outputs, 1 VCOM and 1VBD (for border)
- Power supply:
 - VCI: 2.2 to 3.7V
 - VDDIO: Connect to VCI
 - VDD: 1.8V, regulate from VCI supply
- On chip display RAM
 - Mono B/W: 176x296 bits
 - Mono Red: 176x296 bits
- On-chip booster and regulator for generating VCOM, Gate and Source driving voltage
- Gate driving output voltage: 2-level outputs (VGH, VGL), Max 40Vp-p
 - VGH: 10V to 20V (Voltage adjustment step: 500mV)
 - VGL: -VGH (Voltage adjustment step: 500mV)
- Source / VBD driving output voltage: 4-levels outputs (VSH1, VSH2, VSS and VSL)
 - VSH1/VSH2: 2.4V to 17V (Voltage adjustment step: 100mV for 2.4V to 8.8V, 200mV for 8.8V to 17V)
 - VSL: -5V to -17V (Voltage adjustment step: 500mV)
- VCOM output voltage
 - DCVCOM: -3V to -0.2V in 100mV resolution
 - ACVCOM: 3-level outputs (VSH1+DCVCOM, DCVCOM, VSL+DCVCOM)
- On-chip oscillator, adjustable frame rate from 25Hz to 200Hz
- Programmable output Waveform Settings:
 - Individual setting of 5 LUT [LUT0~4]
 - VS: 2-bit per 4 phases
 - Common setting of 5 LUT
 - 48 phases (4 phases/group, 12 groups with repeat and state repeat function)
 - TP: Max. 255 frame/phase
 - RP: 1 to 256 times for repeat count
 - SR: 1 to 256 times for state repeat count; state repeat count for phase A,B and 1 state repeat count for phase C,D
 - FR: Selective Frame Rate for each group
 - XON: All Gate On Selection for each phase A,B and phase C,D
- Embedded OTP to store the waveform settings and parameters:
 - 36 sets of Waveform Settings (WS) including
 - waveform look up table (LUT),
 - Gate/Source voltage, VCOM value
 - Option for LUT end
 - 36 sets of Temperature Range (TR)
 - Display mode selection
 - 4-byte waveform version
 - 10-byte User ID
- · Embedded OTP to store the init code setting
- External or internal generated voltage for burning OTP
- Built-in CRC checking method for RAM content and WS & TR in OTP
- Panel break diagnostic
- VCI low voltage detection
- Driving voltage ready detection
- Support display partial update

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- Auto write RAM command for regular patterns
- Internal Temperature Sensor of +/-2degC accuracy from -25degC to 50degC
- I2C single master interface to communicate with external temperature sensor
- MCU interface: 4-wire or 3-wire Serial peripheral interface (maximum SPI write speed 20MHz)
- Cascade mode to support displays with higher resolution
- Available in COG package

3 ORDERING INFORMATION

Table 3-1: Ordering Information

| Ordering Part Number | Package Form | Remark |
|----------------------|---------------|--|
| SSD1680Z | Gold Bump Die | Bump Face Up On Waffle pack Die thickness: 300um Bump height: 12um |
| SSD1680Z8 | Gold Bump Die | Bump Face Down On Waffle pack Die thickness: 300um Bump height: 12um |

4 BLOCK DIAGRAM

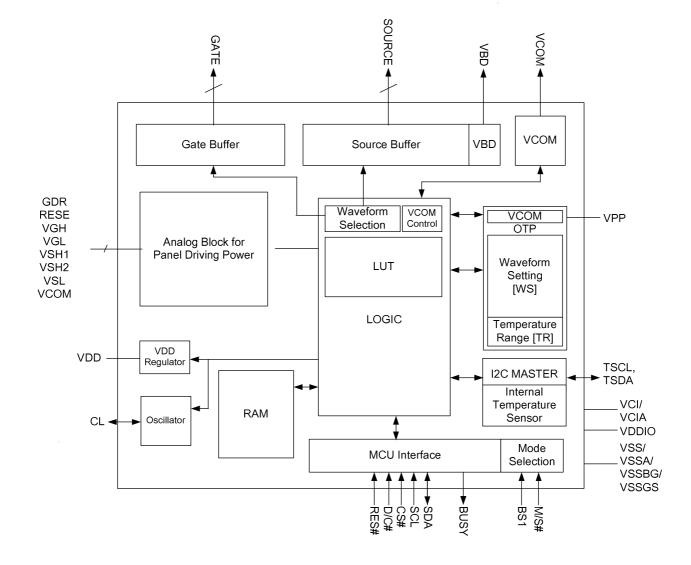


Figure 4-1 : SSD1680 Block Diagram

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5 PIN DESCRIPTION

Key:

I = Input

O =Output

IO = Bi-directional (input/output)

P = Power pin

C = Capacitor Pin

NC = Not Connected

Table 5-1: Power Supply Pins

| Name | Туре | Connect to | Function | Description | When not in use |
|-------|------|-----------------|--------------------------------|--|-----------------|
| VCI | Р | Power Supply | Power Supply | Power input pin for the chip. | - |
| VCIA | P | Power Supply | Power Supply | Power input pin for the chip. - Connect to VCI in the application circuit. | • |
| VDDIO | P | Power Supply | Power for interface logic pins | Power input pin for the Interface Connect to VCI in the application circuit. | - |
| VDD | P | Capacitor | Regulator output | Core logic power pin VDD can be regulated internally from VCI. - For the single chip application, a capacitor should be connected between VDD and VSS under all circumstances. - For the cascade mode application, a capacitor should be connected between VDD and VSS in the master chip under all circumstances. For the slave chip, the capacitor is not necessary as VDD will be supplied from the cascade master chip externally. | |
| VSS | P | VSS | GND | Ground (Digital). | - |
| VSSA | P | VSS | GND | Ground (Analog) - Connect to VSS in the application circuit. | - |
| VSSBG | Р | VSS | GND | Ground (Reference) pin Connect to VSS in the application circuit. | - |
| VSSGS | Р | VSS | GND | Ground (Output) pin Connect to VSS in the application circuit. | - |
| VPP | ₽P | Power Supply | OTP power | Power Supply for OTP Programming. | Open |

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Table 5-2: Interface Logic Pins

| Name | Туре | Connect to | Function | Description | When not in use |
|------|------|------------------------|---|--|-----------------|
| SCL | I | MPU | Data Bus | This pin is serial clock pin for interface. Refer to MCU interface in Section 6.1. | - |
| SDA | I/O | MPU | Data Bus | This pin is serial data pin for interface. Refer to MCU interface in Section 6.1. | - |
| CS# | I | MPU | Logic Control | This pin is the chip select input connecting to the MCU. Refer to MCU interface in Section 6.1. | VDDIO or VSS |
| D/C# | I | MPU | Logic Control | This pin is Data/Command control pin connecting to the MCU. Refer to MCU interface in Section 6.1. | VDDIO or VSS |
| RES# | I | MPU | System Reset | This pin is reset signal input. Active Low. | - |
| BUSY | 0 | MPU | Device Busy Signal | This pin is Busy state output pin. When Busy is High, the operation of the chip should not be interrupted, and command should not be sent. For example., The chip would output Busy pin as High when - Outputting display waveform; or - Programming with OTP - Communicating with digital temperature sensor In the cascade mode, the BUSY pin of the slave chip should be left open. | Open |
| M/S# | I | VDDIO/VSS | Cascade Mode Selection | This pin is Master and Slave selection pin. For the single chip application, the M/S# pin should be connected to VDDIO. In the cascade mode: For Master Chip, the M/S# pin should be connected to VDDIO. For Slave Chip, the M/S# pin should be connected to VSS. The oscillator, booster and regulator circuits of the slave chip will be disabled. The corresponding pins including CL, VDD, VDDIO, VGH, VGL, VSH1, VSH2, VSL and VCOM must be connected to the master chip. | 1 |
| CL | I/O | NC | Clock signal | This pin is the clock signal pin. For the single chip application, the CL pin should be left open. In the cascade mode, the CL pin of the slave chip should be connected to the CL pin of the master chip. | Open |
| BS1 | I | VDDIO/VSS | MCU Interface Mode Selection | This pin is for selecting 3-wire or 4-wire SPI bus. BS1 MCU Interface L 4-wire SPI H 3-wire SPI (9-bit SPI) | 1 |
| TSDA | I/O | Temperature sensor SDA | Interface to Digital Temp. Sensor | This pin is I ² C Interface to digital temperature sensor Data pin. External pull up resistor is required when connecting to I ² C slave. | Open |
| TSCL | 0 | Temperature sensor SCL | Interface to Digital Temp. Sensor | This pin is I ² C Interface to digital temperature sensor Clock pin. External pull up resistor is required when connecting to I ² C slave. | Open |

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Table 5-3: Analog Pins

| Name | Туре | Connect to | Function | Description | When not in use |
|------|------|--------------------------------------|----------------------------------|--|-----------------|
| GDR | 0 | POWER MOSFET Driver Control | VGH, VGL Generation | This pin is N-Channel MOSFET gate drive control pin. | - |
| RESE | I | Booster Control Input | | This pin is Current sense input pin for the control Loop. | - |
| VGH | С | Stabilizing capacitor | | This pin is Positive Gate driving voltage. Connect a stabilizing capacitor between VGH and VSS in the application circuit. | - |
| VGL | С | Stabilizing capacitor | | This pin is Negative Gate driving voltage. Connect a stabilizing capacitor between VGL and VSS in the application circuit. | • |
| VSH1 | С | Stabilizing capacitor | VSH1, VSH2, VSL Generation | This pin is Positive Source driving voltage, VSH1 Connect a stabilizing capacitor between VSH1 and VSS in the application circuit. | - |
| VSH2 | С | Stabilizing capacitor | | This pin is Positive Source driving voltage, VSH2 Connect a stabilizing capacitor between VSH2 and VSS in the application circuit. | |
| VSL | С | Stabilizing capacitor | | This pin is Negative Source driving voltage. Connect a stabilizing capacitor between VSL and VSS in the application circuit. | - |
| VCOM | С | Panel/ Stabilizing capacitor | VCOM Generation | This pins is VCOM driving voltage Connect a stabilizing capacitor between VCOM and VSS in the application circuit. | - |

Table 5-4: Driver Output Pins

| Name | Туре | Connect to | Function | Description | When not in use |
|-----------|------|------------|-----------------------|--------------------|-----------------|
| S [175:0] | 0 | Panel | Source driving signal | Source output pin. | Open |
| G [295:0] | 0 | Panel | Gate driving signal | Gate output pin. | Open |
| VBD | 0 | Panel | Border driving signal | Border output pin. | Open |

Table 5-5: Miscellaneous Pins

| Name | Туре | Connect to | Function | Description | When not in use |
|-----------------------------------|------|------------|-------------------------|---|-----------------|
| NC | NC | NC | Not Connected | This is dummy pin. It should not be connected with other NC pins. | Open |
| RSV | NC | NC | Reserved | This is a reserved pin and should be kept open. | Open |
| TPA, TPB, TPC, TPD, TPF, FB | NC | NC | Reserved for Testing | Reserved pins. - Keep open. - Do not connect to other NC pins and test pins including TPA, TPB, TPC, TPD, TPE, TPF, TIN and FB. | Open |
| TIN | I | NC | Reserved for Testing | This is a reserved pin and should be kept open. | Open |
| TPE | 0 | NC | Reserved for Testing | This is a reserved pin and should be kept open. | Open |

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6 Functional Block Description

6.1 MCU Interface

6.1.1 MCU Interface selection

The SSD1680 can support 3-wire/4-wire serial peripheral. MCU interface is pin selectable by BS1 shown in Table 6-1.

Table 6-1: Interface pins assignment under different MCU interface

| | Pin Name | | | | | |
|---|----------|------|-----|------|-----|-----|
| MCU Interface | BS1 | RES# | CS# | D/C# | SCL | SDA |
| 4-wire serial peripheral interface (SPI) | L | RES# | CS# | DC# | SCL | SDA |
| 3-wire serial peripheral interface (SPI) – 9 bits SPI | Н | RES# | CS# | L | SCL | SDA |

Note

6.1.2 MCU Serial Interface (4-wire SPI)

The 4-wire SPI consists of serial clock SCL, serial data SDA, D/C# and CS#. The control pins status in 4-wire SPI in writing command/data is shown in Table 6-2 and the write procedure 4-wire SPI is shown in Table 6-2

Table 6-2: Control pins status of 4-wire SPI

| Function | SCL pin | SDA pin | D/C# pin | CS# pin |
|---------------|----------|-------------|----------|---------|
| Write command | 1 | Command bit | L | L |
| Write data | ↑ | Data bit | Н | L |

Note:

- (1) L is connected to VSS and H is connected to VDDIO
- (2) ↑ stands for rising edge of signal
- (3) SDA (Write Mode) is shifted into an 8-bit shift register on every rising edge of SCL in the order of D7, D6, ... D0. The level of D/C# should be kept over the whole byte. The data byte in the shift register is written to the Graphic Display Data RAM (RAM)/Data Byte register or command Byte register according to D/C# pin.

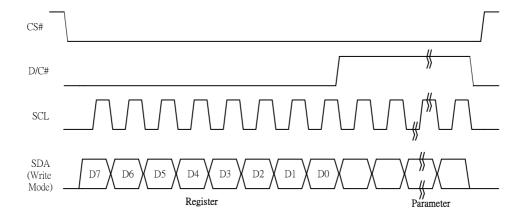


Figure 6-1: Write procedure in 4-wire SPI mode

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 $^{^{(1)}}$ L is connected to V_{SS} and H is connected to V_{DDIO}

In the read operation (Command 0x1B, 0x27, 0x2D, 0x2E, 0x2F, 0x35). After CS# is pulled low, the first byte sent is command byte, D/C# is pulled low. After command byte sent, the following byte(s) read are data byte(s), so D/C# bit is then pulled high. An 8-bit data will be shifted out on every clock falling edge. The serial data SDA bit shifting sequence is D7, D6, to D0 bit. Figure 6-2 shows the read procedure in 4-wire SPI.

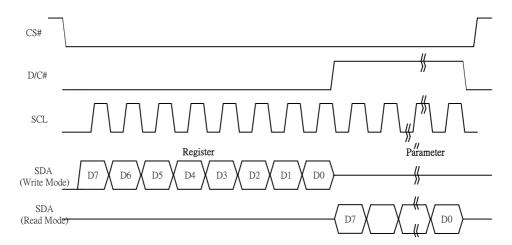


Figure 6-2: Read procedure in 4-wire SPI mode

6.1.3 MCU Serial Peripheral Interface (3-wire SPI)

The 3-wire SPI consists of serial clock SCL, serial data SDA and CS#. The operation is similar to 4-wire SPI while D/C# pin is not used and it must be tied to LOW. The control pins status in 3-wire SPI is shown in Table 6-3.

In the write operation, a 9-bit data will be shifted into the shift register on every clock rising edge. The bit shifting sequence is D/C# bit, D7 bit, D6 bit to D0 bit. The first bit is D/C# bit which determines the following byte is command or data. When D/C# bit is 0, the following byte is command. When D/C# bit is 1, the following byte is data. Table 6-3 shows the write procedure in 3-wire SPI

| Function | SCL pin | SDA pin | D/C# pin | CS# pin |
|---------------|----------|-------------|----------|---------|
| Write command | 1 | Command bit | Tie LOW | L |
| Write data | ↑ | Data bit | Tie LOW | L |

Table 6-3: Control pins status of 3-wire SPI

Note:

- (1) L is connected to V_{SS} and H is connected to V_{DDIO}
- (2) ↑ stands for rising edge of signal

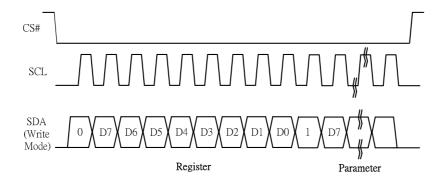


Figure 6-3: Write procedure in 3-wire SPI

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In the read operation (Register 0x1B, 0x27, 0x2D, 0x2E, 0x2F, 0x35). SDA data are transferred in the unit of 9 bits. After CS# pull low, the first byte is command byte, the D/C# bit is as 0 and following with the register byte. After command byte send, the following byte(s) are data byte(s), with D/C# bit is 1. After D/C# bit sending from MCU, an 8-bit data will be shifted out on every clock falling edge. The serial data SDA bit shifting sequence is D7, D6, to D0 bit. Figure 6-4 shows the read procedure in 3-wire SPI.

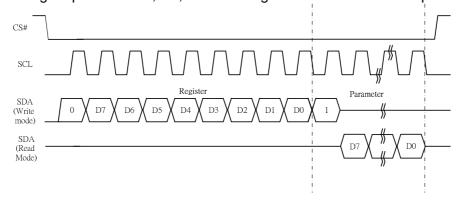


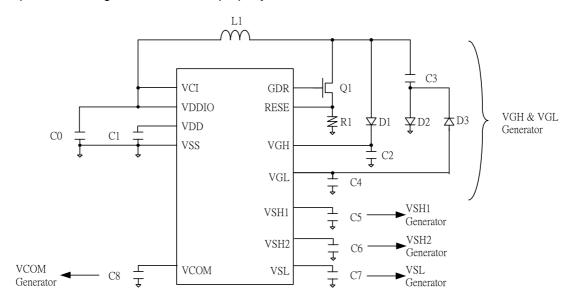
Figure 6-4: Read procedure in 3-wire SPI mode

6.2 OSCILLATOR

The oscillator module generates the clock reference for waveform timing and analog operations.

6.3 BOOSTER & REGULATOR

A voltage generation system is included in the driver. It provides all necessary driving voltages required for an AMEPD panel including VGH, VGL, VSH1, VSH2, VSL and VCOM. External application circuit is needed to make the on-chip booster & regulator circuit work properly.



6.4 VCOM SENSING

This functional block provides the scheme to select the optimal VCOM DC level. The sensed value can be programmed into OTP.

The flow of VCOM sensing:

- Active Gate is scanning during the VCOM sense Period.
- Source are VSS.
- VCOM pin used for sensing.
- During Sensing period, BUSY is high.
- After Sensing, Active Gate return to non-select stage.

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6.5 RAM

The On chip display RAM is holding the image data.

- 1 set of RAM is built for Mono B/W. The RAM size is 176x296 bits.
- 1 set of RAM is built for Mono Red. The RAM size is 176x296 bits.

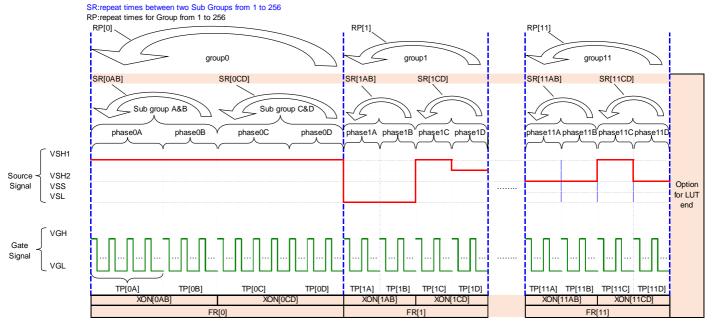
Table 6-4: RAM bit and LUT mapping for 3-color display

| Data bit in R RAM | Data bit in B/W RAM | Image Color | LUT |
|-------------------|---------------------|-------------|-------------------------|
| 0 | 0 | Black | LUT 0 for driving Black |
| 0 | 1 | White | LUT 1 for driving White |
| 1 | 0 | Red | LUT 2 for driving Red |
| 1 | 1 | Red | LUT 3 = LUT2 |

Table 6-5: RAM bit and LUT mapping for black/white display

| Data bit in R RAM | Data bit in B/W RAM | Image Color | LUT |
|-------------------|---------------------|-------------|-------------------------|
| 0 | 0 | Black | LUT 0 for driving Black |
| 0 | 1 | White | LUT 1 for driving White |
| 1 | 0 | Black | LUT 2 = LUT0 |
| 1 | 1 | White | LUT 3 = LUT1 |

6.6 Programmable Waveform for Gate, Source and VCOM



TP: time of phase length from 0 to 255* frames 0indicates phase skipped XON: All Gate On selection for each nAB or nCD.

XON: All Gate On selection for each nAB or nCE FR: Frame frequency selection for each group. EOPT: Option for LUT end

Figure 6-5 : Gate waveform and Programmable Source and VCOM waveform illustration

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In the programmable waveform for Source and VCOM, there are 12 groups (Group0 to Group11) and each group has 4 phases (Phase A to Phase D) and 2 state repeats (Phase A and B, Phase C and D). Totally, there are 48 phases. In addition, in each phase, the phase length (TP[nX]) can be set by number of frame from 0 to 255 frames. Also, each group can be repeated with repeat counting number (RP[n]) from 1 to 256 times; each AB / CD phases can be repeated with state repeat counting number (SR[nAB]/SR[nCD]) from 1 to 256 times. For the voltage, there is four levels for Source voltage (VSS, VSH1, VSH2, VSL) and three levels for VCOM voltage (DCVCOM, VSH1+DCVCOM, VSL+DCVOM).

The description of each parameter is as follows.

- 1) TP[nX] represents the phase length set by the number of frame.
- The range of TP[nX] is from 0 to 255.
- n represents the Group number from 0 to 11; X represents the phase number from A to D.
- When TP[nX] = 0, the phase is skipped. When TP[nX] = 1, the phase is 1 frame, and so on. The maximum phase length is 255 frame.
- 2) RP[n] represents the repeat counting number for the Group.
- The range of RP[n] is from 0 to 255.
- n represents the Group number from 0 to 11.
- RP[n] = 0 indicates that the repeat times =1, RP[n] = 1 indicates that the repeat times = 2, and so on. The maximum repeat times is 256.
- 3) SR[nAB] and SR[nCD] represent the state repeat counting number for Phase A & B and Phase C & D respectively.
- The range of SR[nXY] is from 0 to 255.
- n represents the Group number from 0 to 11.
- SR[nXY] = 0 indicates that the repeat times = 1, SR[nXY] = 1 indicates that the repeat times = 2, and so on. The maximum repeat times is 256.
- 4) VS[nX-LUTm] represents Source and VCOM voltage level which is used in each phase. Table 6-6 shows the voltage settings for source voltage and VCOM voltage.
- n represents the Group number from 0 to 11.
- m represents the LUT number from 0-4.

Table 6-6: VS[nX-LUTm] settings for Source voltage and VCOM voltage

| VS[nX-LUTm] | Source voltage | VCOM voltage |
|-------------|----------------|---------------|
| 00 | VSS | DCVCOM |
| 01 | VSH1 | VSH1 + DCVCOM |
| 10 | VSL | VSL + DCVCOM |
| 11 | VSH2 | N/A |

- 5) FR[n] indicates the frame rate of group n
- The range of FR [n] is from 0 to 7.
- n represents the Group number from 0 to 11.
- 6) XON[nAB] and XON[nCD], indicates the gate scan selection.
- n represents the Group number from 0 to 11.
- XON[nXY] = 0 indicates Normal gate scan in Phase[nX] & Phase[nY].
- XON[nXY] = 1 indicates All gate on, that Gate keeps High until the phase for normal gate scan, in Phase[nX] & Phase[nY].

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6.7 WAVEFORM SETTING

As described in Section 6.6, parameters VS[nX-LUTm], TP[nX], RP[n], SR[nXY], FR[n] and XON[nXY] are used to define the driving waveform. In the SSD1680, there are 159 bytes in the waveform setting to store LUT0, LUT1, LUT2, LUT3 and LUT4, gate voltage, source voltage and frame rate. The waveform LUT of a particular temperature range can be loaded from OTP or written by MCU.

- WS byte 0~152, the content of VS[nX-LUTm], TP[nX], RP[n], SR[nXY], FR[n] and XON[nXY] are defined by Register 0x32
- WS byte 153, the content of Option for LUT end, is the parameter belonging to Register 0x3F.
- WS byte 154, the content of gate level, is the parameter defined by Register 0x03.
- WS byte 155~157, the content of source level, is the parameter defined by Register 0x04.
- WS byte 158, the content of VCOM level, is the parameter defined by Register 0x2C.

The SSD1680 waveform setting is shown in Figure 6-6: Waveform Setting mapping

| | D= D0 | D# D4 | I 20 I 20 | D | | | | | | | |
|--|------------------------|------------------------------------|--------------------------------------|------------|-------|--|--|--|--|--|--|
| addr. | D7 D6 | D5 D4 | D3 D2 | D1 D0 | addr. | D7 D6 D5 D4 D3 D2 D1 D0 | | | | | |
| 0 | VS[0A-L0] | VS[0B-L0] | VS[0C-L0] | VS[0D-L0] | 81 | TP[3A] | | | | | |
| 1 | VS[1A-L0] | VS[1B-L0] | VS[1C-L0] | VS[1D-L0] | 82 | TP[3B] | | | | | |
| 2 | VS[2A-L0] | VS[2B-L0] | VS[2C-L0] | VS[2D-L0] | 83 | SR[3AB] | | | | | |
| 3 | VS[3A-L0] | VS[3B-L0] | VS[3C-L0] | VS[3D-L0] | 84 | TP[3C] | | | | | |
| 4 | VS[3A-L0] VS[4A-L0] | VS[4B-L0] | VS[4C-L0] | VS[4D-L0] | 85 | TP[3D] | | | | | |
| 5 | VS[5A-L0] | VS[5B-L0] | VS[5C-L0] | VS[5D-L0] | 86 | SR[3CD] | | | | | |
| 6 | VS[6A-L0] | VS[6B-L0] | VS[6C-L0] | VS[6D-L0] | 87 | RP[3] | | | | | |
| | VS[7A-L0] | VS[7B-L0] | VS[7C-L0] | VS[7D-L0] | | | | | | | |
| 7 | | | | VS[/D-L0] | 88 | TP[4A] | | | | | |
| 8 | VS[8A-L0] | VS[8B-L0] | VS[8C-L0] | VS[8D-L0] | 89 | TP[4B] | | | | | |
| 9 | VS[9A-L0] | VS[9B-L0] | VS[9C-L0] | VS[9D-L0] | 90 | SR[4AB] | | | | | |
| 10 | VS[10A-L0] | VS[10B-L0] | VS[10C-L0] | VS[10D-L0] | 91 | TP[4C] | | | | | |
| 11 | VS[11A-L0] | VS[11B-L0] | VS[11C-L0] | VS[11D-L0] | 92 | TP[4D] | | | | | |
| | | | | | | | | | | | |
| 12 | VS[0A-L1] | VS[0B-L1] | VS[0C-L1] | VS[0D-L1] | 93 | SR[4CD] | | | | | |
| 13 | VS[1A-L1] | VS[1B-L1] | VS[1C-L1] | VS[1D-L1] | 94 | RP[4] | | | | | |
| 14 | VS[2A-L1] | VS[2B-L1] | VS[2C-L1] | VS[2D-L1] | 95 | TP[5A] | | | | | |
| 15 | VS[3A-L1] | VS[3B-L1] | VS[3C-L1] | VS[3D-L1] | 96 | TP[5B] | | | | | |
| 16 | VS[4A-L1] | VS[4B-L1] | VS[4C-L1] | VS[4D-L1] | 97 | SR[5AB] | | | | | |
| 17 | VS[5A-L1] | VS[5B-L1] | VS[5C-L1] | VS[5D-L1] | 98 | TP[5C] | | | | | |
| 18 | VS[6A-L1] | VS[6B-L1] | VS[6C-L1] | VS[6D-L1] | 99 | TP[5D] | | | | | |
| 19 | VS[7A-L1] | VS[7B-L1] | VS[7C-L1] | VS[7D-L1] | 100 | | | | | | |
| | | | | | | SR[5CD] | | | | | |
| 20 | VS[8A-L1] | VS[8B-L1] | VS[8C-L1] | VS[8D-L1] | 101 | RP[5] | | | | | |
| 21 | VS[9A-L1] | VS[9B-L1] | VS[9C-L1] | VS[9D-L1] | 102 | TP[6A] | | | | | |
| 22 | VS[10A-L1] | VS[10B-L1] | VS[10C-L1] | VS[10D-L1] | 103 | TP[6B] | | | | | |
| 23 | VS[11A-L1] | VS[11B-L1] | VS[11C-L1] | VS[11D-L1] | 104 | SR[6AB] | | | | | |
| 24 | VS[0A-L2] | VS[0B-L2] | VS[0C-L2] | VS[0D-L2] | 105 | TP[6C] | | | | | |
| 25 | VS[1A-L2] | VS[1R-L2] | VS[1C-L2] | VS[1D-L2] | 106 | TP[6D] | | | | | |
| 26 | VS[34 L2] | VS[3D L3] | V(212-112) | VS[2D L2] | 107 | | | | | | |
| | V S[ZA-LZ] | V3[2B-L2] | V3[2U-L2] | V 3[ZD-LZ] | | SR[6CD] | | | | | |
| 27 | VS[3A-L2] | VS[3B-L2] | VS[3C-L2] | VS[3D-L2] | 108 | RP[6] | | | | | |
| 28 | VS[4A-L2] | VS[4B-L2] | VS[4C-L2] | VS[4D-L2] | 109 | TP[7A] | | | | | |
| 29 | VS[5A-L2] | VS[5B-L2] | VS[5C-L2] | VS[5D-L2] | 110 | TP[7B] | | | | | |
| 30 | VS[6A-L2] | VS[6B-L2] | VS[6C-L2] | VS[6D-L2] | 111 | SR[7AB] | | | | | |
| 31 | VS[7A-L2] | VS[7B-L2] | VS[7C-L2] | VS[7D-L2] | 112 | TP[7C] | | | | | |
| 32 | VS[8A-L2] | VS[8B-L2] | VS[8C-L2] | VS[8D-L2] | 113 | TP[7D] | | | | | |
| 33 | VSIQV T 21 | VS[0D L2] | VS[00 L2] | VS[0D L2] | 114 | SR[7CD] | | | | | |
| | V3[9A-L2] | V3[3D-L2] | VS[10C-L2] | VS[9D-L2] | | | | | | | |
| 34 | VS[10A-L2] | VS[10B-L2] | VS[10C-L2] | VS[10D-L2] | 115 | RP[7] | | | | | |
| 35 | VS[11A-L2] | VS[11B-L2] | VS[11C-L2] | VS[11D-L2] | 116 | TP[8A] | | | | | |
| 36 | VS[0A-L3] | VS[0B-L3] | VS[0C-L3] | VS[0D-L3] | 117 | TP[8B] | | | | | |
| 37 | VS[1A-L3] | VS[1B-L3] | VS[1C-L3] | VS[1D-L3] | 118 | SR[8AB] | | | | | |
| 38 | VS[2A-L3] | VS[2B-L3] | VS[2C-L3] | VS[2D-L3] | 119 | TP[8C] | | | | | |
| 39 | VS[3A-L3] | VS[3B-L3] | VS[3C-L3] | VS[3D-L3] | 120 | TP[8D] | | | | | |
| 40 | VS[4A-L3] | VS[4B-L3] | VS[4C-L3] | VS[4D-L3] | 121 | SR[8CD] | | | | | |
| 41 | | | | | | | | | | | |
| | VS[5A-L3] | VS[5B-L3] | VS[5C-L3] | VS[5D-L3] | 122 | RP[8] | | | | | |
| 42 | VS[6A-L3] | VS[6B-L3] | VS[6C-L3] | VS[6D-L3] | 123 | TP[9A] | | | | | |
| 43 | VS[7A-L3] | VS[7B-L3] | VS[7C-L3] | VS[7D-L3] | 124 | TP[9B] | | | | | |
| 44 | VS[8A-L3] | VS[8B-L3] | VS[8C-L3] | VS[8D-L3] | 125 | SR[9AB] | | | | | |
| 45 | VS[9A-L3] | VS[9B-L3] | VS[9C-L3] | VS[9D-L3] | 126 | TP[9C] | | | | | |
| 46 | VS[10A-L3] | VS[10B-L3] | VS[10C-L3] | VS[10D-L3] | 127 | TP[9D] | | | | | |
| 47 | VS[11A-L3] | VS[11B-L3] | VS[11C-L3] | VS[11D-L3] | 128 | SR[9CD] | | | | | |
| 48 | VS[1A-L3] VS[0A-L4] | VS[1B-L3] VS[0B-L4] | VS[11C-L3] | VS[11D-L3] | 129 | RP[9] | | | | | |
| | | | | | | | | | | | |
| 49 | VS[1A-L4] | VS[1B-L4] | VS[1C-L4] | VS[1D-L4] | 130 | TP[10A] | | | | | |
| 50 | VS[2A-L4] | VS[2B-L4] | VS[2C-L4] | VS[2D-L4] | 131 | TP[10B] | | | | | |
| 51 | VS[3A-L4] | VS[3B-L4] | VS[3C-L4] | VS[3D-L4] | 132 | SR[10AB] | | | | | |
| 52 | VS[4A-L4] | VS[4B-L4] | VS[4C-L4] | VS[4D-L4] | 133 | TP[10C] | | | | | |
| 53 | VS[5A-L4] | VS[5B-L4] | VS[5C-L4] | VS[5D-L4] | 134 | TP[10D] | | | | | |
| 54 | VS[6A-L4] | VS[6B-L4] | VS[6C-L4] | VS[6D-L4] | 135 | SR[10CD] | | | | | |
| 55 | VS[7A-L4] | VS[7B-L4] | VS[7C-L4] | VS[7D-L4] | 136 | RP[10] | | | | | |
| 56 | VS[8A-L4] | VS[8B-L4] | VS[8C-L4] | VS[8D-L4] | 137 | TP[11A] | | | | | |
| 57 | VS[9A-L4] | VS[9B-L4] | VS[9C-L4] | VS[9D-L4] | 138 | | | | | | |
| | | | | | | TP[11B] | | | | | |
| 58 | VS[10A-L4] | VS[10B-L4] | VS[10C-L4] | VS[10D-L4] | 139 | SR[11AB] | | | | | |
| 59 | VS[11A-L4] | VS[11B-L4] | VS[11C-L4] | VS[11D-L4] | 140 | TP[11C] | | | | | |
| 60 | | | [0A] | | 141 | TP[11D] | | | | | |
| 61 | | TP | [0B] | | 142 | SR[11CD] | | | | | |
| 62 | | SRI | 0AB] | | 143 | RP[11] | | | | | |
| 63 | | | | | 144 | | | | | | |
| | | | [0C] | | | | | | | | |
| 64 | | | [0D] | | 145 | FR[2] FR[3] | | | | | |
| 65 | | SR[| 0CD] | | 146 | FR[4] FR[5] | | | | | |
| 66 | | | P[0] | | 147 | FR[6] FR[7] | | | | | |
| 67 | | TP | [1A] | | 148 | FR[8] FR[9] | | | | | |
| 68 | | | [1B] | | 149 | FR[10] FR[11] | | | | | |
| 69 | | | 1AB] | | 150 | XON[0AB] XON[0CD] XON[1AB] XON[1CD] XON[2AB] XON[2CD] XON[3AB] XON[3CD | | | | | |
| 70 | l | JIC DT | [1C] | | 151 | XON[4AB] XON[4CD] XON[5AB] XON[5CD] XON[6AB] XON[6CD] XON[7AB] XON[7CD | | | | | |
| | } | TD | [1D] | | 152 | XON[4AB] XON[4CD] XON[5AB] XON[5CD] XON[6AB] XON[6CD] XON[7AB] XON[7CD XON[8AB] XON[8CD] XON[9AB] XON[9CD] XON[10AB] XON[10CD] XON[11AB] XON[11CD XON[11AB] XON[11A | | | | | |
| | | IP OF | 100 | | | | | | | | |
| 71 | | | 1CD] | | 153 | EOPT | | | | | |
| 72 | | RI | P[1] | | 154 | VGH | | | | | |
| 72 73 | | | 10.11 | | 155 | VSH1 | | | | | |
| 72 | | TP | [2A] | | 450 | | | | | | |
| 72 | | TP | | | 156 | VSH2 | | | | | |
| 72 73 74 75 | | TP TP | [2B] | | | | | | | | |
| 72 73 74 75 76 | | TP TP SR[| [2B] 2AB] | | 157 | VSL | | | | | |
| 72 73 74 75 76 | | TP TP SR(TP | [2B] 2AB] [2C] | | | | | | | | |
| 72 73 74 75 76 77 | | TP TP SRI TP TP | [2B] 2AB] [2C] [2D] | | 157 | VSL | | | | | |
| 72 73 74 75 76 77 78 79 | | TP TP SR(TP TP SR(| [2B] 2AB] [2C] [2D] 2CD] | | 157 | VSL | | | | | |
| 72 73 74 75 76 77 78 | | TP TP SR(TP TP SR(| [2B] 2AB] [2C] [2D] | | 157 | VSL | | | | | |

Figure 6-6: Waveform Setting mapping

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6.8 Temperature Searching

The SSD1680 has internal temperature sensor to detect the environment temperature or can communicate with the external temperature sensor by I2C single master interface or can communicate with the external MCU to get the temperature value through SPI. In the SSD1680, there is a dedicated format for the temperature value so that the driver IC can understand it. The format of temperature value is described in Section 6.8.3.

6.8.1 Internal Temperature Sensor

The internal temperature sensor can be selected by command register. The accuracy of it is ±2degC from - 25degC to 50degC.

6.8.2 External Temperature Sensor I2C Single Master Interface

The driver IC can communicate with the external temperature sensor through I2C single master interface (TSDA and TSCL). TSDA will be SDA and TSCL will be SCL. TSDA and TSCL are required to connect with external pull-up resistor. Temperature register value of external temperature sensor can be read by command register.

6.8.3 Format of temperature value

The temperature value is defined by 12-bit binary. The rules are shown as below.

- If the Temperature value MSByte bit D11 = 0, then the temperature is positive and value (DegC) = + (Temperature value) / 16
- If the Temperature value MSByte bit D11 = 1, then the temperature is negative and value (DegC) = (2's complement of Temperature value) / 16

Table 6-7 shows some examples of 12-bit binary temperature value:

Table 6-7: Example of 12-bit binary temperature settings for temperature ranges

| 12-bit binary (2's complement) | Hexadecimal Value | TR Value [DegC] |
|--------------------------------|----------------------|-----------------|
| 0111 1111 1111 | 7FF | 128 |
| 0111 1111 1111 | 7FF | 127.9 |
| 0110 0100 0000 | 640 | 100 |
| 0101 0000 0000 | 500 | 80 |
| 0100 1011 0000 | 4B0 | 75 |
| 0011 0010 0000 | 320 | 50 |
| 0001 1001 0000 | 190 | 25 |
| 0000 0000 0100 | 004 | 0.25 |
| 0000 0000 0000 | 000 | 0 |
| 1111 1111 1100 | FFC | -0.25 |
| 1110 0111 0000 | E70 | -25 |
| 1100 1001 0000 | C90 | -55 |

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6.9 Waveform Setting searching mechanism

As mentioned in Section 6.7, the SSD1680 OTP can store waveform setting and temperature range. If waveform setting and temperature range are programmed in OTP memory, corresponding waveform LUT can be selected according to the sensed temperature to drive the display. The Waveform Setting searching mechanism by driver IC is as follows.

- 1) Read temperature value by command register in the format of 12-bit binary.
- 2) According to read temperature and display mode selection, search LUT in OTP from TR0 to TR35 in sequence. The last match will be selected, then, the corresponding WS will be loaded in the LUT register to drive the display.

Remark: Waveform LUT selection criteria is "Lower temperature bound < Sensed temperature ≤ Upper temperature bound".

Table 6-8 shows an example for the waveform LUT searching from OTP:

- If the read temperature is 25degC, then, WS4 will be selected.
- If the read temperature is 34degC, then, WS7 will be selected. Although 34degC is also in the temperature range TR6, according to searching mechanism, the last match should be selected. Therefore, WS7 is selected.

| Waveform LUT in OTP | Temperature Range in OTP | TR Lower Limit [Hex] | TR Upper Limit [Hex] | Temperature range in OTP |
|------------------------|--------------------------|-------------------------|----------------------|-----------------------------------|
| WS0 | TR0 | 800 | 050 | -128 DegC < Temperature ≤ 5 DegC |
| WS1 | TR1 | 050 | 0A0 | 5 DegC < Temperature ≤ 10DegC |
| WS2 | TR2 | 0A0 | 0F0 | 10 DegC < Temperature ≤ 15DegC |
| WS3 | TR3 | 0F0 | 140 | 15 DegC < Temperature ≤ 20DegC |
| WS4 | TR4 | 140 | 190 | 20 DegC < Temperature ≤ 25DegC |
| WS5 | TR5 | 190 | 1E0 | 25 DegC < Temperature ≤ 30DegC |
| WS6 | TR6 | 1E0 | 230 | 30 DegC < Temperature ≤ 35DegC |
| WS7 | TR7 | 210 | 7FF | 33 DegC < Temperature ≤ 127.9DegC |
| Others | Others | 000 | 000 | |

Table 6-8: Example of waveform settings selection based on temperature ranges.

Precaution:

Please ensure the temperature range covers whole range of application temperatures, display will not be updated if no suitable temperature range matches the sensed temperature.

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6.10 One Time Programmable (OTP) Memory

In the SSD1680, there is an embedded OTP memory which is designed to store the waveform settings of different temperature range and some variables/parameters. The OTP memory can store 36 sets of waveform LUT settings (WS), 36 sets of temperature range (TR), VCOM value, display mode selection, waveform version and user ID. Figure 6 7 shows the address mapping of the 36 waveform setting (WS0 to WS35) and temperature range (TR0 to TR35).

| addr. | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | | | | |
|--------------|----|-----|----|------|-----------------|----|----|----|--|--|--|--|
| 0 | | | | 144 | | | | | | | | |
| 450 | | | | W | 50 | | | | | | | |
| 158 | | | | | | | | | | | | |
| 159 | | | | \\/ | S1 | | | | | | | |
| 317 | | WS1 | | | | | | | | | | |
| 318 | | | | | | | | | | | | |
| | | | | W | S2 | | | | | | | |
| 476 | | | | ••• | - | | | | | | | |
| 477 | | | | | | | | | | | | |
| | | | | W | S3 | | | | | | | |
| 635 | | | | | | | | | | | | |
| 636 | | | | | | | | | | | | |
| | | | | W | S4 | | | | | | | |
| 794 | | | | ••• | - | | | | | | | |
| | | | | | | | | | | | | |
| | | | | | | | | | | | | |
| | | | | | | | | | | | | |
| 5406 | | | | 1000 | 204 | | | | | | | |
| | | | | WS | 634 | | | | | | | |
| 5564 | | | | | | | | | | | | |
| 5565 | | | | WS | 225 | | | | | | | |
| 5723 | | | | VV | 555 | | | | | | | |
| 5724 | | | | | | | | | | | | |
| 5725 | | | | TF | RO | | | | | | | |
| 5726 | | | | | | | | | | | | |
| 5727 | | | | | | | | | | | | |
| 5728 | | | | TF | ₹1 | | | | | | | |
| 5729 | | | | | | | | | | | | |
| 5730 | | | | | | | | | | | | |
| 5731 | | | | TF | R2 | | | | | | | |
| 5732 | | | | | | | | | | | | |
| 5733 | | | | | | | | | | | | |
| 5734 | | | | TF | ๙Ӡ | | | | | | | |
| 5735 | | | | | | | | | | | | |
| 5736 5737 | | | | TF | 24 | | | | | | | |
| 5737 | | | | IF | \ -1 | | | | | | | |
| 3736 | | | | | | | | | | | | |
| | | | | | | | | | | | | |
| | | | | •• | | | | | | | | |
| 5826 | | | | | | | | | | | | |
| 5827 | | | | TR | 34 | | | | | | | |
| 5828 | | | | | | | | | | | | |
| 5829 | | | | | | | | | | | | |
| 5830 | | | | TR | 35 | | | | | | | |
| 5831 | | | | | | | | | | | | |

Figure 6-7: The Waveform setting mapping in OTP for waveform setting and temperature range

6.11 The Format for Temperature Range (TR)

The format of TR Lower limit and Upper limit as shown in Figure 6-8 which temp_L[11:0] is the lower limit and temp_H[11:0] is the upper limit of the temperature range. There has 36sets of TR for waveform LUT searching.

| D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | | | | | |
|----|--------------------------|----|----|----|----|----|----|--|--|--|--|--|
| | temp_L[7:0] | | | | | | | | | | | |
| | temp_H[3:0] temp_L[11:8] | | | | | | | | | | | |
| | temp_H[11:4] | | | | | | | | | | | |

Figure 6-8: Format of Temperature Range (TR) in OTP

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6.12 Cascade Mode

SSD1680 has a cascade mode that can cascade 2 chips to achieve the display resolution up to 352 (sources) x 296 (gates). The pin M/S# is used to configure the chip. When M/S# is connected to VDDIO, the chip is configured as a master chip. When M/S# is connected to VSS, the chip is configured as a slave chip.

When the chip is configured as a master chip, it will be the same as a single chip application, ie, all circuit blocks will be worked as usual. When the chip is configured as a slave chip, its oscillator and booster & regulator circuit will be disabled. The oscillator clock and all booster voltages will be come from the master chip. Therefore, the corresponding pins including CL, VDD, VGH, VGL, VSH1, VSH2, VSL, VGL and VCOM must be connected to the master chip.

6.13 VCI Detection

The VCI detection function is used to detect the VCI level when it is lower than Vlow, threshold voltage set by register.

In SSD1680, there is a command to execute the VCI detection function. When the VCI detection command is issued, the VCI detection will be executed. During the detection period, BUSY output is at high level. BUSY output is at low level when the detection is completed. Then, user can issue the Status Bit Read command to check the status bit for the result of VCI, which 0 is normal, 1 is VCI<VIow.

6.14 HV Ready Detection

The HV Ready detection function is used to detect whether the analog block is ready.

In SSD1680, there is a command to execute the HV Ready detection function. When the HV Ready detection command is issued, the HV Ready will be executed. During the detection period, BUSY output is at high level. BUSY output is at low level when the detection is completed. Then, user can issue the Status Bit Read command to check the status bit for the result of HV Ready, which 0 is normal, 1 indicate HV is not ready.

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7 COMMAND TABLE

Table 7-1: Command Table

| Com | Command Table | | | | | | | | | | | | | | |
|------|---------------|-----|----------------|----------------|----------------|----------------|-----------------------|----------------|----------------|----------------|-----------------------|---|--|--|--|
| R/W# | D/C# | Hex | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Command | Descripti | on | | |
| 0 | 0 | 01 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | Driver Output control | Gate setti | | | |
| 0 | 1 | | A ₇ | A ₆ | A ₅ | A ₄ | A ₃ | A ₂ | A ₁ | A ₀ | · | A[8:0]= 12 | | | |
| 0 | 1 | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | A ₈ | | MUX Gate | e lines set | tting as (A | [8:0] + 1). |
| 0 | 1 | | 0 | 0 | 0 | 0 | 0 | B ₂ | B ₁ | B ₀ | | B[2:0] = 0 | UU IBUBI | | |
| | | | , | | | | | | | | | | | | I direction |
| | | | | | | | | | | | | output sec GD=1, G1 is the output sec B[1]: SM Change s SM=0 [PC G0, G1, G interlaced SM=1, G0, G2, G B[0]: TB TB = 0 [PC | OR], 1st gate of quence is 1st gate of quence is canning of DR], 62, G32) OR], scan | output cha G0,G1, G output cha G1, G0, G order of ga 95 (left ar 4, G1, G3 | nnel, gate G3, G2, te driver. dright gate , G295 |
| | | | | | | | | | | | | TB = 1, so | an from C | 3295 to G | U |
| 0 | 0 | 03 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | Gate Driving voltage | Set Gate | driving vo | ltage | |
| 0 | 1 | 00 | 0 | 0 | 0 | A ₄ | A ₃ | A ₂ | - 4 A₁ | A ₀ | Control | A[4:0] = 0 | | | |
| | ' | | O | O | U | 714 | 713 | 712 | ^ | 710 | | | | 0V to 20V | , |
| | | | | | | | | | | | | A[4:0] | VGH | A[4:0] | VGH |
| | | | | | | | | | | | | 00h | 20 | 0Dh | 15 |
| | | | | | | | | | | | | 03h | 10 | 0Eh | 15.5 |
| | | | | | | | | | | | | 04h | 10.5 | 0Fh | 16 |
| | | | | | | | | | | | | 05h | 11 | 10h | 16.5 |
| | | | | | | | | | | | | 06h | 11.5 | 11h | 17 |
| | | | | | | | | | | | | 07h | 12 | 12h | 17.5 |
| | | | | | | | | | | | | 08h | 12.5 | 13h | 18 |
| | | | | | | | | | | | | 07h | 12 | 14h | 18.5 |
| | | | | | | | | | | | | 08h | 12.5 | 15h | 19 |
| | | | | | | | | | | | | 09h | 13 | 16h | 19.5 |
| | | | | | | | | | | | | 0Ah | 13.5 | 17h | 20 |
| | | | | | | | | | | | | 0Bh 0Ch | 14 14.5 | Other | NA |
| | | | | | | | | | | | | UCII | 14.5 | | |
| | | | | | | | | | | | | | | | |
| | 1 | | | | | | l | | l | | L | 1 | | | |

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| Com | Command Table | | | | | | | | | | | |
|------|---------------|-----|-----------------------|----------------|-----------------------|----------------|-----------------------|----------------|----------------|----------------|---------|--|
| R/W# | D/C# | Hex | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Command | Description |
| 0 | 0 | 04 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | | 0 0 |
| 0 | 1 | | A ₇ | A_6 | A_5 | A ₄ | A ₃ | A ₂ | A ₁ | A ₀ | Control | A[7:0] = 41h [POR], VSH1 at 15V |
| 0 | 1 | | B ₇ | B ₆ | B ₅ | B ₄ | B ₃ | B ₂ | B ₁ | B ₀ | | B[7:0] = A8h [POR], VSH2 at 5V. C[7:0] = 32h [POR], VSL at -15V |
| 0 | 1 | | C ₇ | C ₆ | C ₅ | C ₄ | Сз | C ₂ | C ₁ | C ₀ | | Remark: VSH1>=VSH2 |

A[7]/B[7] = 1, VSH1/VSH2 voltage setting from 2.4V to 8.8V

| H2 |
|----|
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| |

A[7]/B[7] = 0, VSH1/VSH2 voltage setting from 9V to 17V

| A/B[7:0] | VSH1/VSH2 | A/B[7:0] | VSH1/VSH2 | | |
|----------|-----------|----------|-----------|--|--|
| 23h | 9 | 3Ch | 14 | | |
| 24h | 9.2 | 3Dh | 14.2 | | |
| 25h | 9.4 | 3Eh | 14.4 | | |
| 26h | 9.6 | 3Fh | 14.6 | | |
| 27h | 9.8 | 40h | 14.8 | | |
| 28h | 10 | 41h | 15 | | |
| 29h | 10.2 | 42h | 15.2 | | |
| 2Ah | 10.4 | 43h | 15.4 | | |
| 2Bh | 10.6 | 44h | 15.6 | | |
| 2Ch | 10.8 | 45h | 15.8 | | |
| 2Dh | 11 | 46h | 16 | | |
| 2Eh | 11.2 | 47h | 16.2 | | |
| 2Fh | 11.4 | 48h | 16.4 | | |
| 30h | 11.6 | 49h | 16.6 | | |
| 31h | 11.8 | 4Ah | 16.8 | | |
| 32h | 12 | 4Bh | 17 | | |
| 33h | 12.2 | Other | NA | | |
| 34h | 12.4 | | | | |
| 35h | 12.6 | | | | |
| 36h | 12.8 | | | | |
| 37h | 13 | | | | |
| 38h | 13.2 | | | | |
| 39h | 13.4 | | | | |
| 3Ah | 13.6 | | | | |
| 3Bh | 13.8 | | | | |

C[7] = 0, VSL setting from -5V to -17V

| C[7:0] | VSL |
|--------|-------|
| 0Ah | |
| 0Ch | -5.5 |
| 0Eh | -6 |
| 10h | -6.5 |
| 12h | -7 |
| 14h | -7.5 |
| 16h | -8 |
| 18h | -8.5 |
| 1Ah | -9 |
| 1Ch | -9.5 |
| 1Eh | -10 |
| 20h | -10.5 |
| 22h | -11 |
| 24h | -11.5 |
| 26h | -12 |
| 28h | -12.5 |
| 2Ah | -13 |
| 2Ch | -13.5 |
| 2Eh | -14 |
| 30h | -14.5 |
| 32h | -15 |
| 34h | -15.5 |
| 36h | -16 |
| 38h | -16.5 |
| 3Ah | -17 |
| Other | NA |

| 0 | 0 | 08 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | Initial Code Setting OTP Program | Program Initial Code Setting |
|---|---|----|----------------|----------------|----------------|-----------------------|-----------------------|----------------|----------------|----------------|--|--|
| | | | | | | | | | | | - | The command required CLKEN=1. Refer to Register 0x22 for detail. BUSY pad will output high during operation. |
| | , | | | | • | | | | • | | | |
| 0 | 0 | 09 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 1 | Write Register for Initial | |
| 0 | 1 | | A ₇ | A_6 | A_5 | A ₄ | A_3 | A_2 | A ₁ | A_0 | Code Setting | Selection |
| 0 | 1 | | B ₇ | B_6 | B ₅ | B ₄ | B ₃ | B_2 | B ₁ | B ₀ | | A[7:0] ~ D[7:0]: Reserved Details refer to Application Notes of Initial |
| 0 | 1 | | C ₇ | C_6 | C 5 | C ₄ | C ₃ | C ₂ | C ₁ | C ₀ | | Code Setting |
| 0 | 1 | | D ₇ | D ₆ | D ₅ | D ₄ | D ₃ | D ₂ | D ₁ | D ₀ | | - |
| 0 | 0 | 0A | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | Read Register for Initial Code Setting | Read Register for Initial Code Setting |

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| Com | man | d Tak | ole | | | | | | | | | | |
|------|------|-------|-----|----------------|-----------------------|----------------|----------------|----------------|----------------|----------------|--------------------|--------------------------|--|
| R/W# | D/C# | Hex | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Command | Description | |
| 0 | 0 | 0C | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | Booster Soft start | | with Phase 1, Phase 2 and Phase 3 |
| 0 | 1 | | 1 | A ₆ | A ₅ | A_4 | A_3 | A ₂ | A ₁ | A ₀ | Control | | rent and duration setting. |
| 0 | 1 | | 1 | B ₆ | B ₅ | B ₄ | Вз | B ₂ | B ₁ | B ₀ | | | art setting for Phase1 |
| 0 | 1 | | 1 | C_6 | C ₅ | C ₄ | C ₃ | C ₂ | C ₁ | C ₀ | | B[7:0] -> Soft sta | ı [POR] art setting for Phase2 |
| 0 | 1 | | 0 | 0 | D ₅ | D ₄ | D ₃ | D ₂ | D ₁ | D ₀ | | = 9Ch | art setting for Phase3 |
| | | | | | | | | | | | | = 96h | [POR] |
| | | | | | | | | | | | | D[7:0] -> Duration = 0Fh | on setting [POR] |
| | | | | | | | | | | | | | otion of each byte: 6:0] / C[6:0]: |
| | | | | | | | | | | | | Bit[6:4] | Driving Strength Selection |
| | | | | | | | | | | | | 000 | 1(Weakest) |
| | | | | | | | | | | | | 001 | 2 |
| | | | | | | | | | | | | 010 | 3 |
| | | | | | | | | | | | | 011 | 4 |
| | | | | | | | | | | | | 100 | 5 |
| | | | | | | | | | | | | 101 | 6 |
| | | | | | | | | | | | | 110 | 7 |
| | | | | | | | | | | | | 111 | 8(Strongest) |
| | | | | | | | | | | | | Bit[3:0] | Min Off Time Setting of GDR [Time unit] |
| | | | | | | | | | | | | 0000 | NA |
| | | | | | | | | | | | | 0011 | |
| | | | | | | | | | | | | 0100 | 2.6 |
| | | | | | | | | | | | | 0101 | 3.2 |
| | | | | | | | | | | | | 0110 | 3.9 |
| | | | | | | | | | | | | 0111 | 4.6 |
| | | | | | | | | | | | | 1000 | 5.4 |
| | | | | | | | | | | | | 1001 | 6.3 |
| | | | | | | | | | | | | 1010 | 7.3 |
| | | | | | | | | | | | | 1011 | 8.4 |
| | | | | | | | | | | | | 1100 | 9.8 11.5 |
| | | | | | | | | | | | | 1110 | 13.8 |
| | | | | | | | | | | | | 1111 | 16.5 |
| | | | | | | | | | | | | D[5:4]: du D[3:2]: du | ration setting of phase uration setting of phase 3 uration setting of phase 2 uration setting of phase 1 Duration of Phase [Approximation] 10ms 20ms |
| | | | | | | | | | | | | | 30ms |
| | | | | | | | | | | | | 11 | 40ms |

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|------|------|------|-----|----|----|----|----|----------------|----------------|----------------|--------------------------|--|
| R/W# | D/C# | Hex | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Command | Description |
| | | | | | | 1 | • | 1 | | | | |
| 0 | 0 | 10 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | Deep Sleep mode | Deep Sleep mode Control: |
| 0 | 1 | | 0 | 0 | 0 | 0 | 0 | 0 | A_1 | A_0 | | A[1:0]: Description |
| | | | | | | | | | | | | 00 Normal Mode [POR] |
| | | | | | | | | | | | | 01 Enter Deep Sleep Mode 1 |
| | | | | | | | | | | | | 11 Enter Deep Sleep Mode 2 |
| | | | | | | | | | | | | After this command initiated, the chip will enter Deep Sleep Mode, BUSY pad will keep output high. Remark: To Exit Deep Sleep mode, User required to send HWRESET to the driver |
| 0 | 0 | 11 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 1 | Data Entry mode setting | Define data entry sequence |
| 0 | 1 | | 0 | 0 | 0 | 0 | 0 | A ₂ | A ₁ | A ₀ | Data Littly mode setting | A[2:0] = 011 [POR] |
| | • | | | 0 | Ü | U | 0 | A2 | Ai | Ao | | A [1:0] = ID[1:0] Address automatic increment / decrement setting The setting of incrementing or decrementing of the address counter can be made independently in each upper and lower bit of the address. 00 —Y decrement, X decrement, 01 —Y decrement, X increment, 10 —Y increment, X decrement, 11 —Y increment, X increment [POR] A[2] = AM Set the direction in which the address counter is updated automatically after data are written to the RAM. AM= 0, the address counter is updated in the X direction. [POR] AM = 1, the address counter is updated in the Y direction. |
| 0 | 0 | 12 | 0 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | SW RESET | It resets the commands and parameters to their S/W Reset default values except R10h-Deep Sleep Mode During operation, BUSY pad will output high. |
| | | | - | | | | | | | | | Note: RAM are unaffected by this command. |
| | | | | | | | | | | | | |

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|------|------|------|-----------------------|---------------------|---------------------|---------------------|---------------------|----------------|-----------------------|-----------------------|-------------------------------|--|
| R/W# | D/C# | Hex | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Command | Description |
| 0 | 0 | 14 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | HV Ready Detection | HV ready detection A[7:0] = 00h [POR] The command required CLKEN=1 and ANALOGEN=1. Refer to Register 0x22 for detail. After this command initiated, HV Ready detection starts. BUSY pad will output high during detection. The detection result can be read from the Status Bit Read (Command 0x2F). |
| 0 | 1 | | 0 | A ₆ | A ₅ | A ₄ | 0 | A ₂ | A ₁ | A ₀ | | A[6:4]=n for cool down duration: 10ms x (n+1) A[2:0]=m for number of Cool Down Loop to detect. The max HV ready duration is 10ms x (n+1) x (m) HV ready detection will be trigger after each cool down time. The detection will be completed when HV is ready. For 1 shot HV ready detection, A[7:0] can be set as 00h. |
| 0 | 0 | 15 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | 1 | VCI Detection | VCI Detection |
| 0 | 1 | 2 | 0 | 0 | 0 | 0 | 0 | A2 | A ₁ | Ao | VOI Detection | A[2:0] = 100 [POR] , Detect level at 2.3V A[2:0] : VCI level Detect A[2:0] VCI level 011 2.2V 100 2.3V 101 2.4V 110 2.5V 111 2.6V Other NA The command required CLKEN=1 and ANALOGEN=1 Refer to Register 0x22 for detail. After this command initiated, VCI detection starts. BUSY pad will output high during detection. The detection result can be read from the Status Bit Read (Command 0x2F). |
| 0 | 0 | 18 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | Tomporature Sensor | Tomporature Songer Solection |
| 0 | 1 | 7 | A ₇ | 0 A ₆ | 0 A ₅ | 1 A ₄ | 1 A ₃ | A ₂ | 0 A ₁ | 0 A ₀ | Temperature Sensor Control | Temperature Sensor Selection A[7:0] = 48h [POR], external temperatrure sensor A[7:0] = 80h Internal temperature sensor |
| 0 | 0 | 1A | 0 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | Temperature Sensor | Write to temperature register. |
| 0 | 1 | | A ₁₁ | A ₁₀ | A 9 | A ₈ | A ₇ | A ₆ | A ₅ | A ₄ | Control (Write to | A[11:0] = 7FFh [POR] |
| 0 | 1 | | A ₃ | A ₂ | A ₁ | A ₀ | 0 | 0 | 0 | 0 | temperature register) | |
| 0 | 0 | 1B | 0 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | Temperature Sensor | Read from temperature register. |
| 1 | 1 | - | A ₁₁ | A ₁₀ | A ₉ | A ₈ | A ₇ | A ₆ | A ₅ | A ₄ | Control (Read from | , |
| 1 | 1 | | A ₃ | A ₂ | A ₁ | A ₀ | 0 | 0 | 0 | 0 | temperature register) | |
| | | | | - | | | | - | | <u> </u> | • | |

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|------|------|------|-----------------------|----------------|----------------|----------------|-----------------------|----------------|----------------|----------------|-------------------------|--|
| R/W# | D/C# | Hex | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Command | Description |
| | | | | | | | | | | | | |
| 0 | 0 | 1C | 0 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | Temperature Sensor | Write Command to External temperature |
| 0 | 1 | | A ₇ | A ₆ | A ₅ | A ₄ | A ₃ | A ₂ | A ₁ | A ₀ | Control (Write Command | sensor. |
| 0 | 1 | | B ₇ | B ₆ | B ₅ | B ₄ | B ₃ | B ₂ | B ₁ | B ₀ | to External temperature | A[7:0] = 00h [POR], |
| 0 | 1 | | C ₇ | C ₆ | C ₅ | C ₄ | C ₃ | C ₂ | C ₁ | | sensor) | B[7:0] = 00h [POR], |
| " | | | O/ | 06 | O ₅ | O 4 | O ₃ | 02 | O1 | Co | | C[7:0] = 00h [POR], |
| | | | | | | | | | | | | A[7:6] A[7:6] Select no of byte to be sent 00 Address + pointer 01 Address + pointer + 1st parameter 10 Address + pointer + 1st parameter + 2nd pointer 11 Address A[5:0] - Pointer Setting B[7:0] - 1st parameter C[7:0] - 2nd parameter The command required CLKEN=1. Refer to Register 0x22 for detail. After this command initiated, Write Command to external temperature sensor starts. BUSY pad will output high during |
| 0 | 0 | 20 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | Master Activation | operation. Activate Display Update Sequence |
| | | | | | | | | | | | | The Display Update Sequence Option is located at R22h. |
| | | | | | | | | | | | | BUSY pad will output high during operation. User should not interrupt this operation to avoid corruption of panel images. |
| | l _ | | _ | _ | | | | l _ | | ١. | <u> </u> | |
| 0 | 0 | 21 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | | Display Update Control | RAM content option for Display Update A[7:0] = 00h [POR] |
| 0 | 1 | | A ₇ | A_6 | A_5 | A_4 | A ₃ | A ₂ | A ₁ | A ₀ | 1 | A[7:0] = 001 [POR] B[7:0] = 00h [POR] |
| 0 | 1 | | B ₇ | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | |
| | | | | | | | | | | | | A[7:4] Red RAM option |
| | | | | | | | | | | | | 0000 Normal |
| | | | | | | | | | | | | 0100 Bypass RAM content as 0 |
| | | | | | | | | | | | | 1000 Inverse RAM content |
| | | | | | | | | | | | | A[3:0] BW RAM option |
| | | | | | | | | | | | | 0000 Normal |
| | | | | | | | | | | | | 0100 Bypass RAM content as 0 |
| | | | | | | | | | | | | 1000 Inverse RAM content |
| | | | | | | | | | | | | B[7] Source Output Mode |
| | | | | | | | | | | | | 0 Available Source from S0 to S175 |
| | | | | | | | | | | | | 1 Available Source from S8 to S167 |
| | | | | | | | | | | | | |
| | | | | | | | | | | | | |

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|------|------|------|----------------|-------|-------|-------|-------|-------|----------------|-------|-------------------------|---|--------------|
| R/W# | D/C# | Hex | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Command | Description | |
| 0 | 0 | 22 | 0 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | Display Update | Display Update Sequence Option | |
| 0 | 1 | | A ₇ | A_6 | A_5 | A_4 | A_3 | A_2 | A ₁ | A_0 | Control 2 | Enable the stage for Master Act | tivation |
| | | | | | | | | | | | | A[7:0]= FFh (POR) | Parameter |
| | | | | | | | | | | | | Operating sequence | (in Hex) |
| | | | | | | | | | | | | Enable clock signal | 80 |
| | | | | | | | | | | | | Disable clock signal | 01 |
| | | | | | | | | | | | | Enable clock signal | C0 |
| | | | | | | | | | | | | → Enable Analog | , 00 |
| | | | | | | | | | | | | Disable Analog → Disable clock signal | 03 |
| | | | | | | | | | | | | | |
| | | | | | | | | | | | | Enable clock signal → Load LUT with DISPLAY Mode 1 | 91 |
| | | | | | | | | | | | | → Disable clock signal | 31 |
| | | | | | | | | | | | | Enable clock signal | 00 |
| | | | | | | | | | | | | → Load LUT with DISPLAY Mode 2→ Disable clock signal | 99 |
| | | | | | | | | | | | | | |
| | | | | | | | | | | | | Enable clock signal → Load temperature value | |
| | | | | | | | | | | | | → Load LUT with DISPLAY Mode 1 | B1 |
| | | | | | | | | | | | | → Disable clock signal | |
| | | | | | | | | | | | | Enable clock signal → Load temperature value | |
| | | | | | | | | | | | | → Load LUT with DISPLAY Mode 2 | B9 |
| | | | | | | | | | | | | → Disable clock signal | |
| | | | | | | | | | | | | Enable clock signal | |
| | | | | | | | | | | | | → Enable Analog | 07 |
| | | | | | | | | | | | | → Display with DISPLAY Mode 1→ Disable Analog | C7 |
| | | | | | | | | | | | | → Disable OSC | |
| | | | | | | | | | | | | Enable clock signal → Enable Analog | |
| | | | | | | | | | | | | → Display with DISPLAY Mode 2 | CF |
| | | | | | | | | | | | | → Disable Analog→ Disable OSC | |
| | | | | | | | | | | | | 7 2.000.0 | |
| | | | | | | | | | | | | Enable clock signal | |
| | | | | | | | | | | | | → Enable Analog→ Load temperature value | F-7 |
| | | | | | | | | | | | | → DISPLAY with DISPLAY Mode 1 | F7 |
| | | | | | | | | | | | | → Disable Analog→ Disable OSC | |
| | | | | | | | | | | | | Enable clock signal | |
| | | | | | | | | | | | | → Enable Analog→ Load temperature value | |
| | | | | | | | | | | | | → DISPLAY with DISPLAY Mode 2 | FF |
| | | | | | | | | | | | | → Disable Analog→ Disable OSC | |
| | | | | - | | | | | l | l | l | | |
| 0 | 0 | 24 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | Write RAM (Black White) | After this command, data entrie | s will be |
| | | | | | | | | | | | / RAM 0x24 | written into the BW RAM until a | |
| | | | | | | | | | | | | command is written. Address po | ointers will |
| | | | | | | | | | | | | advance accordingly | |
| | | | | | | | | | | | | For Write pixel: | |
| | | | | | | | | | | | | For Write pixel: Content of Write RAM(BW) = | 1 |
| | | | | | | | | | | | | For Black pixel: | • |
| | | | | | | | | | | | | Content of Write RAM(BW) = 0 | 0 |
| | | | | | | | | | | | <u> </u> | | |
| L | | | | | | | | | | | | | |

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|-----|------|------|-----|----|----|----|----------------|----------------|----------------|----------------|-------------------------------|--|
| | D/C# | | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Command | Description |
| 0 | 0 | 26 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | 0 | Write RAM (RED) / RAM 0x26 | After this command, data entries will be written into the RED RAM until another command is written. Address pointers will advance accordingly. For Red pixel: |
| | | | | | | | | | | | | Content of Write RAM(RED) = 1 For non-Red pixel [Black or White]: Content of Write RAM(RED) = 0 |
| 0 | 0 | 27 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | 1 | Read RAM | After this command, data read on the MCU bus will fetch data from RAM. According to parameter of Register 41h to select reading RAM0x24/ RAM0x26, until another command is written. Address pointers will advance accordingly. |
| | | | | | | | | | | | | The 1st byte of data read is dummy data. |
| 0 | 0 | 28 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 0 | VCOM Sense | Enter VCOM sensing conditions and hold for duration defined in 29h before reading VCOM value. The sensed VCOM voltage is stored in register The command required CLKEN=1 and ANALOGEN=1 Refer to Register 0x22 for detail. |
| | | | | | | | | | | | | BUSY pad will output high during operation. |
| 0 | 0 | 29 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 1 | VCOM Sense Duration | Stabling time between entering VCOM |
| 0 | 1 | 29 | 0 | 1 | 0 | 0 | A ₃ | A ₂ | A ₁ | A ₀ | | sensing mode and reading acquired. A[3:0] = 9h, duration = 10s. VCOM sense duration = (A[3:0]+1) sec |
| | | I | | | | | | | | I | | |
| 0 | 0 | 2A | 0 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | Program VCOM OTP | Program VCOM register into OTP The command required CLKEN=1. Refer to Register 0x22 for detail. BUSY pad will output high during operation. |
| 0 | 0 | 2B | 0 | 0 | 1 | 0 | 1 | 0 | 1 | 1 | Write Register for VCOM | This command is used to reduce glitch |
| 0 | 1 | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | Control | when ACVCOM toggle. Two data bytes D04h and D63h should be set for this command. |
| | | | | | | | | | | | | |

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|------|------|------|-----------------------|----------------|-----------------------|-----------------------|-----------------------|----------------|----------------|-----------------------|-----------------------|------------|-------------------|--------------|---------------|
| R/W# | D/C# | Hex | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Command | Descrip | tion | | |
| 0 | 0 | 2C | 0 | 0 | 1 | 0 | 1 | 1 | 0 | 0 | Write VCOM register | Write VC | COM registe | er from M | ICU interface |
| 0 | 1 | | A ₇ | A ₆ | A ₅ | A ₄ | A ₃ | A ₂ | A ₁ | A ₀ | | A[7:0] = | 00h [POR] | | |
| | | | | | | | | | | | | A[7:0] | VCOM | A[7:0] | VCOM |
| | | | | | | | | | | | | 08h | -0.2 | 44h | -1.7 |
| | | | | | | | | | | | | 0Ch | -0.3 | 48h | -1.8 |
| | | | | | | | | | | | | 10h | -0.4 | 4Ch | -1.9 |
| | | | | | | | | | | | | 14h | -0.5 | 50h | -2 |
| | | | | | | | | | | | | 18h | -0.6 | 54h | -2.1 |
| | | | | | | | | | | | | 1Ch | -0.7 | 58h | -2.2 |
| | | | | | | | | | | | | 20h | -0.8 | 5Ch | -2.3 |
| | | | | | | | | | | | | 24h | -0.9 | 60h | -2.4 |
| | | | | | | | | | | | | 28h | -1 | 64h | -2.5 |
| | | | | | | | | | | | | 2Ch | -1.1 | 68h | -2.6 |
| | | | | | | | | | | | | 30h | -1.2 | 6Ch | -2.7 |
| | | | | | | | | | | | | 34h | -1.3 | 70h | -2.8 |
| | | | | | | | | | | | | 38h | -1.4 | 74h | -2.9 |
| | | | | | | | | | | | | 3Ch 40h | -1.5 -1.6 | 78h Other | -3 NA |
| | | | | | | | | | | | | 4011 | -1.0 | Other | INA |
| 0 | 0 | 2D | 0 | 0 | 1 | 0 | 1 | 1 | 0 | 1 | OTP Register Read for | Read R | Register for | Display (| Option: |
| 1 | 1 | | A ₇ | A ₆ | A_5 | A ₄ | A ₃ | A_2 | A ₁ | A ₀ | Display Option | A [7, O]. | VOOMOT | D O - I 4: | |
| 1 | 1 | | B ₇ | B ₆ | B ₅ | B ₄ | Вз | B ₂ | B ₁ | B ₀ | | | VCOM OT and 0x37, | | on |
| 1 | 1 | | C ₇ | C ₆ | C ₅ | C ₄ | C ₃ | C ₂ | C ₁ | C ₀ | | (Comm | iailu uxu, | Dyte A) | |
| 1 | 1 | | D ₇ | D ₆ | D ₅ | D ₄ | D ₃ | D ₂ | D ₁ | D ₀ | | | VCOM Reg | gister | |
| 1 | 1 | | E ₇ | E ₆ | E ₅ | E ₄ | E ₃ | E_2 | E ₁ | E ₀ | | (Comm | and 0x2C) | | |
| 1 | 1 | | F ₇ | F ₆ | F ₅ | F ₄ | F ₃ | F ₂ | F ₁ | F ₀ | | C[7:0]~ | ·G[7:0]: Dis | nlav Mod | le |
| 1 | 1 | | G ₇ | G_6 | G_5 | G ₄ | G ₃ | G_2 | G₁ | G_0 | | | and 0x37, | | |
| 1 | 1 | | H ₇ | H ₆ | H ₅ | H ₄ | H ₃ | H ₂ | H₁ | H ₀ | | [5 byte: | s] | • | • , |
| 1 | 1 | | l ₇ | I ₆ | I ₅ | I ₄ | l ₃ | l ₂ | I ₁ | · I ₀ | | H[7:0]~ | ·K[7:0]: Wa | veform V | ersion |
| 1 | 1 | | J_7 | J_6 | J 5 | J_4 | J ₃ | J_2 | J ₁ | J_0 | | | and 0x37, | | |
| 1 | 1 | | K ₇ | K ₆ | K ₅ | K ₄ | K ₃ | K ₂ | K ₁ | K ₀ | | (4 byte | | • | • / |
| | | | | | | | | | | | | | | | |
| 0 | 0 | 2E | 0 | 0 | 1 | 0 | 1 | 1 | 1 | 0 | User ID Read | |) Byte User | | |
| 1 | 1 | | A ₇ | A ₆ | A_5 | A ₄ | A ₃ | A ₂ | A ₁ | A ₀ | | | | ID (R38, | Byte A and |
| 1 | 1 | | B ₇ | B ₆ | B ₅ | B ₄ | Вз | B ₂ | B ₁ | B ₀ | | Ryte J) | [10 bytes] | | |
| 1 | 1 | | C ₇ | C ₆ | C ₅ | C ₄ | C ₃ | C ₂ | C ₁ | C ₀ | 1 | | | | |
| 1 | 1 | | D ₇ | D ₆ | D ₅ | D ₄ | D ₃ | D ₂ | D ₁ | D ₀ | 1 | | | | |
| 1 | 1 | | E ₇ | E ₆ | E ₅ | E ₄ | E ₃ | E ₂ | E ₁ | E ₀ | 1 | | | | |
| 1 | 1 | | F ₇ | F ₆ | F ₅ | F ₄ | F ₃ | F ₂ | F ₁ | F ₀ | 1 | | | | |
| 1 | 1 | | G ₇ | G ₆ | G ₅ | G ₄ | G ₃ | G ₂ | G ₁ | G ₀ | | | | | |
| 1 | 1 | | H ₇ | H ₆ | H ₅ | H ₄ | H ₃ | H ₂ | H₁ | H ₀ | | | | | |
| 1 | 1 | | I ₇ | I ₆ | I ₅ | I ₄ | I ₃ | l ₂ | I ₁ | Io | 1 | | | | |
| 1 | 1 | | J ₇ | J ₆ | J ₅ | J ₄ | J ₃ | J ₂ | J ₁ | J ₀ | 1 | | | | |
| | • | | -1 | -0 | -3 | | -3 | -2 | | | <u> </u> | 1 | | | |
| | | | | | | | | | | | | | | | |

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|------|------|------|-----------------|-----------------------|-----------------------|----------------|-----------------------|-----------------|----------------|----------------|----------------------|--|
| R/W# | D/C# | Hex | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Command | Description |
| 0 | 0 | 2F | 0 | 0 | 1 | 0 | 1 | 1 | 1 | 1 | Status Bit Read | Read IC status Bit [POR 0x01] |
| 1 | 1 | | 0 | 0 | A_5 | A_4 | 0 | 0 | A_1 | A_0 | | A[5]: HV Ready Detection flag [POR=0] |
| | | | | | | | | | | | | 0: Ready 1: Not Ready |
| | | | | | | | | | | | | A[4]: VCI Detection flag [POR=0] |
| | | | | | | | | | | | | 0: Normal |
| | | | | | | | | | | | | 1: VCI lower than the Detect level |
| | | | | | | | | | | | | A[3]: [POR=0] |
| | | | | | | | | | | | | A[2]: Busy flag [POR=0] 0: Normal |
| | | | | | | | | | | | | 1: BUSY |
| | | | | | | | | | | | | A[1:0]: Chip ID [POR=01] |
| | | | | | | | | | | | | Remark: |
| | | | | | | | | | | | | A[5] and A[4] status are not valid after RESET, they need to be initiated by |
| | | | | | | | | | | | | command 0x14 and command 0x15 |
| | | | | | | | | | | | | respectively. |
| | | 00 | _ | ^ | 4 | | ^ | _ | ^ | ^ | D | D OTD . (M |
| 0 | 0 | 30 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0 | Program WS OTP | Program OTP of Waveform Setting The contents should be written into RAM |
| | | | | | | | | | | | | before sending this command. |
| | | | | | | | | | | | | - |
| | | | | | | | | | | | | The command required CLKEN=1. Refer to Register 0x22 for detail. |
| | | | | | | | | | | | | BUSY pad will output high during |
| | | | | | | | | | | | | operation. |
| | | | | | | | | | | | | |
| 0 | 0 | 31 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 1 | Load WS OTP | Load OTP of Waveform Setting |
| | | | | | | | | | | | | |
| | | | | | | | | | | | | The command required CLKEN=1. |
| | | | | | | | | | | | | Refer to Register 0x22 for detail. |
| | | | | | | | | | | | | BUSY pad will output high during |
| | | | | | | | | | | | | operation. |
| | | | | | | | | | | | | |
| 0 | 0 | 32 | 0 | 0 | 1 | 1 1 | 0 | 0 | 1 | 0 | Write LUT register | Write LUT register from MCU interface |
| 0 | 1 | JZ | A ₇ | A ₆ | A ₅ | A ₄ | A ₃ | A ₂ | A ₁ | A ₀ | I ville LOT Tegister | [153 bytes], which contains the content of |
| 0 | 1 | | B ₇ | B ₆ | B ₅ | H ₄ | B ₃ | B ₂ | B ₁ | B ₀ | | VS[nX-LUTm], TP[nX], RP[n], SR[nXY], |
| 0 | 1 | | ارا | ٠ | : | ٠ | : | رن | ار | ٠. | | FR[n] and XON[nXY] |
| 0 | 1 | | • | • | • | • | • | • | • | • | | Refer to Session 6.7 WAVEFORM SETTING |
| | ' | | • | | • | • | ٠ | • | • | • | | 3 |
| 0 | 0 | 34 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | 0 | CRC calculation | CRC calculation command |
| 0 | U | 34 | U | U | 1 | 1 | U | ı | U | U | CAC Calculation | For details, please refer to SSD1680 |
| | | | | | | | | | | | | application note. |
| | | | | | | | | | | | | DHOV durille to this bet |
| | | | | | | | | | | | | BUSY pad will output high during operation. |
| | | | | | | | | | | | I | |
| 0 | 0 | 35 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | 1 | CRC Status Read | CRC Status Read |
| 1 | 1 | | A ₁₅ | A ₁₄ | | | A ₁₁ | A ₁₀ | A ₉ | A ₈ | | A[15:0] is the CRC read out value |
| 1 | 1 | | A ₇ | A ₆ | A ₅ | A_4 | A ₃ | A_2 | A ₁ | A_0 | | |
| | | | | | | | | | | | | |

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| R/W# | D/C# | Hex | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Command | Description |
| 0 | 0 | 36 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | 0 | Program OTP selection | Program OTP Selection according to the OTP Selection Control [R37h and R38h] |
| | | | | | | | | | | | | The command required CLKEN=1. Refer to Register 0x22 for detail. BUSY pad will output high during operation. |
| | | 07 | 0 | 0 | 4 | 4 | _ | 4 | 4 | _ | Wite Desister for Display | Write Desigter for Display Ontion |
| 0 | 0 | 37 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | 0 | Write Register for Display Option | Write Register for Display Option A[7] Spare VCOM OTP selection |
| 0 | 1 | | A ₇ | 0 B ₆ | 0 B ₅ | 0 B ₄ | 0 B ₃ | 0 B ₂ | 0 B ₁ | B ₀ | - | 0: Default [POR] |
| 0 | 1 | | C ₇ | C ₆ | C ₅ | C ₄ | C ₃ | C ₂ | C ₁ | C ₀ | | 1: Spare |
| 0 | 1 | | D ₇ | D ₆ | D ₅ | D ₄ | D ₃ | D_2 | D ₁ | D_0 | | B[7:0] Display Mode for WS[7:0] |
| 0 | 1 | | E ₇ | E ₆ | E ₅ | E ₄ | E ₃ | E ₂ | E ₁ | E ₀ | | C[7:0] Display Mode for WS[15:8] |
| 0 | 1 | | 0 | F ₆ | 0 | 0 | F ₃ | F ₂ | F ₁ | F ₀ | | D[7:0] Display Mode for WS[23:16] E[7:0] Display Mode for WS[31:24] |
| 0 | 1 | | G ₇ | G ₆ | G ₅ | G ₄ | G ₃ | G ₂ | G ₁ | G ₀ | | F[3:0 Display Mode for WS[35:32] |
| 0 | 1 | | H ₇ | H ₆ | H ₅ | H ₄ | H ₃ | H ₂ | H ₁ | H ₀ | | 0: Display Mode 1 |
| 0 | 1 | | I ₇ | I ₆ | I ₅ | I ₄ | l ₃ | l ₂ | I ₁ | I ₀ | | 1: Display Mode 2 |
| 0 | 1 | | J ₇ | J ₆ | J ₅ | J ₄ | J ₃ | J_2 | J ₁ | J ₀ | | F[6]: PingPong for Display Mode 2 0: RAM Ping-Pong disable [POR] 1: RAM Ping-Pong enable |
| | | | | | | | | | | | | G[7:0]~J[7:0] module ID /waveform version. |
| | | | | | | | | | | | | Remarks: 1) A[7:0]~J[7:0] can be stored in OTP 2) RAM Ping-Pong function is not support for Display Mode 1 |
| | | | | | | | | | | | : | T |
| 0 | 0 | 38 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | 0 | Write Register for User ID | Write Register for User ID A[7:0]]~J[7:0]: UserID [10 bytes] |
| 0 | 1 | | A ₇ | A ₆ | A ₅ | A ₄ | A ₃ | A ₂ | A ₁ | A ₀ | | A[7.0]]-0[7.0]. Oschib [10 bytes] |
| 0 | 1 | | C ₇ | B ₆ | B ₅ | B ₄ | B ₃ | B ₂ | B ₁ | B ₀ | | Remarks: A[7:0]~J[7:0] can be stored in OTP |
| 0 | 1 | | D ₇ | D ₆ | D ₅ | D ₄ | D ₃ | D ₂ | D ₁ | D ₀ | | OTP |
| 0 | 1 | | E ₇ | E ₆ | E ₅ | E ₄ | E ₃ | E ₂ | E ₁ | E ₀ | | |
| 0 | 1 | | F ₇ | F ₆ | F ₅ | F ₄ | F ₃ | F ₂ | F ₁ | F ₀ | | |
| 0 | 1 | | G ₇ | G ₆ | G ₅ | G ₄ | G ₃ | G ₂ | G ₁ | G ₀ | | |
| 0 | 1 | | H ₇ | H ₆ | H ₅ | H ₄ | H ₃ | H ₂ | H₁ | H₀ | | |
| 0 | 1 | | I ₇ | l 6 | I 5 | I ₄ | l ₃ | l ₂ | I ₁ | I ₀ | | |
| 0 | 1 | | J_7 | J_6 | J 5 | J_4 | J ₃ | J_2 | J ₁ | J_0 | | |
| 0 | 0 | 39 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | 1 | OTP program mode | OTP program mode |
| 0 | 1 | 38 | 0 | 0 | 0 | 0 | 0 | 0 | A ₁ | A ₀ | OTP program mode | OTP program mode A[1:0] = 00: Normal Mode [POR] A[1:0] = 11: Internal generated OTP programming voltage |
| | | | | | | | | | | | | Remark: User is required to EXACTLY follow the reference code sequences |
| | | | | | | | | | | | | |

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|------|------|------|----------------|----------------|-----------------------|----------------|----------------|----------------|----------------|-----------------------|-------------------------|--|
| R/W# | D/C# | Hex | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Command | Description |
| 0 | 0 | 3C | 0 | 0 | 1 | 1 | 1 | 1 | 0 | 0 | Border Waveform Control | Select border waveform for VBD |
| 0 | 1 | | A ₇ | A ₆ | A ₅ | A ₄ | 0 | A ₂ | A ₁ | A ₀ | | A[7:0] = C0h [POR], set VBD as HIZ. |
| ~ | | | , ,, | 7.0 | 7.5 | 7 14 | | 7.2 | 7 (1 | 7.0 | | A [7:6] :Select VBD option |
| | | | | | | | | | | | | A[7:6] Select VBD as |
| | | | | | | | | | | | | 00 GS Transition, |
| | | | | | | | | | | | | Defined in A[2] and |
| | | | | | | | | | | | | A[1:0] |
| | | | | | | | | | | | | 01 Fix Level, |
| | | | | | | | | | | | | Defined in A[5:4] 10 VCOM |
| | | | | | | | | | | | | 11[POR] HiZ |
| | | | | | | | | | | | | TI[FOR] |
| | | | | | | | | | | | | A [5:4] Fix Level Setting for VBD |
| | | | | | | | | | | | | A[5:4] VBD level |
| | | | | | | | | | | | | 00 VSS |
| | | | | | | | | | | | | 01 VSH1 |
| | | | | | | | | | | | | 10 VSL |
| | | | | | | | | | | | | 11 VSH2 |
| | | | | | | | | | | | | |
| | | | | | | | | | | | | A[2] GS Transition control |
| | | | | | | | | | | | | A[2] GS Transition control |
| | | | | | | | | | | | | 0 Follow LUT |
| | | | | | | | | | | | | (Output VCOM @ RED) |
| | | | | | | | | | | | | 1 Follow LUT |
| | | | | | | | | | | | | A [1:0] GS Transition setting for VBD |
| | | | | | | | | | | | | A[1:0] VBD Transition |
| | | | | | | | | | | | | 00 LUT0 |
| | | | | | | | | | | | | 01 LUT1 |
| | | | | | | | | | | | | 10 LUT2 |
| | | | | | | | | | | | | 11 LUT3 |
| | | | | l | l | 1 | l | | | | ' | |
| 0 | 0 | 3F | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | End Option (EOPT) | Option for LUT end |
| 0 | 1 | | A ₇ | A ₆ | A ₅ | A ₄ | A ₃ | A ₂ | A ₁ | A ₀ | , , , , | A[7:0]= 02h [POR] |
| | • | | , | 7.0 | 7.5 | | 7.5 | 7.12 | 7 11 | 7.0 | | 22h Normal. |
| | | | | | | | | | | | | 07h Source output level keep |
| | | | | | | | | | | | | previous output before power off |
| | 1 | | | 1 | 1 | 1 | | | | 1 | | |
| 0 | 0 | 41 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | Read RAM Option | Read RAM Option |
| 0 | 1 | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | A_0 | | A[0]= 0 [POR] |
| | | | | | | | | | | | | 0 : Read RAM corresponding to RAM0x24 |
| | | | | | | | | | | | | 1 : Read RAM corresponding to RAM0x26 |
| | | | | <u> </u> | <u> </u> | <u> </u> | <u> </u> | | | | 1 | |
| 0 | 0 | 44 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | Set RAM X - address | Specify the start/end positions of the |
| | | 44 | | | | | | | | | Start / End position | window address in the X direction by an |
| 0 | 1 | | 0 | 0 | A ₅ | A ₄ | A ₃ | A ₂ | A ₁ | A ₀ | Start / Ena position | address unit for RAM |
| 0 | 1 | | 0 | 0 | B ₅ | B ₄ | Вз | B_2 | B ₁ | B ₀ | | |
| | | | | | | | | | | | | A[5:0]: XSA[5:0], XStart, POR = 00h |
| L | | | | | | L | | L | | | | B[5:0]: XEA[5:0], XEnd, POR = 15h |
| | | | | | | | | | | | | |
| 0 | 0 | 45 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 1 | Set Ram Y- address | Specify the start/end positions of the |
| 0 | 1 | | A ₇ | A ₆ | A 5 | A ₄ | Аз | A ₂ | A ₁ | A ₀ | Start / End position | window address in the Y direction by an |
| 0 | 1 | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | A ₈ | 1 | address unit for RAM |
| 0 | 1 | | B ₇ | B ₆ | B ₅ | B ₄ | B ₃ | B ₂ | B ₁ | B ₀ | 1 | 10.01. VC 10.01 VC+o++ DOD 000h |
| 0 | | | | | 0 | | 0 | | | | - | A[8:0]: YSA[8:0], YStart, POR = 000h B[8:0]: YEA[8:0], YEnd, POR = 127h |
| U | 1 | | 0 | 0 | U | 0 | U | 0 | 0 | B ₈ | | D[0.0]. 12/10.0], 12/10, 1 01(- 12/11 |
| | | | | | | | | | | | | |

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| Com | Command Table | | | | | | | | | | | | | | |
|------|---------------|-----|---------------------|---------------------|---------------------|---------------------|----|---------------------|---------------------|---------------------|---|--|---|---|--|
| R/W# | D/C# | Hex | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Command | Descripti | on | | |
| 0 | 0 | 46 | 0 | 1 | 0 | 0 | 0 | 1 | 1 | 0 | Auto Write RED RAM for | Auto Write | RED RA | M for Reg | ular Pattern |
| 0 | 1 | | A ₇ | A ₆ | A ₅ | A ₄ | 0 | A_2 | A ₁ | A ₀ | Regular Pattern | A[7:0] = 0 | | Ü | |
| | | | A7 | A6 | As | A4 | 0 | A ₂ | Ai | Ao | | A[7]: The A[6:4]: Ste Step of alt to Gate A[6:4] 000 001 010 011 A[2:0]: Ste | 1st step varieties Height, let RAM in Height 8 16 32 64 ep Width, let RAM in Width 8 16 32 64 ed will output between the step will be step will be step with the step will be | POR= 000 1 Y-direction 100 101 110 111 POR= 000 1 X-direction 100 101 110 111 | Height 128 256 296 NA On according Width 128 176 NA NA |
| 0 | 0 1 | 47 | 0 A ₇ | 1 A ₆ | 0 A ₅ | 0 A ₄ | 0 | 1 A ₂ | 1 A ₁ | 1 A ₀ | Auto Write B/W RAM for Regular Pattern | Auto Write A[7:0] = 0 A[7]: The A[6:4]: Ste | 0h [POR] 1st step va | alue, POR | |
| | | | | | | | | | | | | | | | on according |
| | | | | | | | | | | | | A[6:4] | Height | A[6:4] | Height |
| | | | | | | | | | | | | 000 | 8 | 100 | 128 |
| | | | | | | | | | | | | 001 | 16 | 101 | 256 |
| | | | | | | | | | | | | 010 011 | 32 64 | 110 111 | 296 NA |
| | | | | | | | | | | | | A[2:0]: Ste | ep Width, lter RAM in Width 8 16 32 64 | POR= 000 A X-direction A[2:0] 100 101 110 111 | Width 128 176 NA NA |

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| Com | man | d Ta | ble | | | | | | | | | | | | |
|------|------|------|-------|-------|-----------------------|----------------|-----------------------|----------------|----------------|----------------|-------------------|--|--|--|--|
| R/W# | D/C# | Hex | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Command | Description | | | |
| 0 | 0 | 4E | 0 | 1 | 0 | 0 | 1 | 1 | 1 | 0 | Set RAM X address | Make initial settings for the RAM X | | | |
| 0 | 1 | | 0 | 0 | A ₅ | A ₄ | A ₃ | A ₂ | A ₁ | A ₀ | counter | address in the address counter (AC) A[5:0]: 00h [POR]. | | | |
| | | | | | | | | | | | | | | | |
| 0 | 0 | 4F | 0 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | Set RAM Y address | Make initial settings for the RAM Y | | | |
| 0 | 1 | | A_7 | A_6 | A_5 | A_4 | A ₃ | A_2 | A ₁ | A_0 | counter | address in the address counter (AC) A[8:0]: 000h [POR]. | | | |
| 0 | 1 | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | A ₈ | | A[8.0]. 000H [POR]. | | | |
| | | | | | | | | | | | | | | | |
| 0 | 0 | 7F | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | NOP | This command is an empty command; it does not have any effect on the display module. However it can be used to terminate Frame Memory Write or Read Commands. | | | |

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8 COMMAND DESCRIPTION

8.1 Driver Output Control (01h)

This triple byte command has multiple configurations and each bit setting is described as follows:

| R/W | DC | IB7 | IB6 | IB5 | IB4 | IB3 | IB2 | IB1 | IB0 |
|-----|----|------|------|------|------|------|------|------|------|
| W | 1 | MUX7 | MUX6 | MUX5 | MUX4 | MUX3 | MUX2 | MUX1 | MUX0 |
| PC |)R | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| W | 1 | | | | | | | | MUX8 |
| PC |)R | | | | | | | | 1 |
| W | 1 | | | | | | GD | SM | TB |
| PC |)R | | | | | | 0 | 0 | 0 |

MUX[8:0]: Specify number of lines for the driver: MUX[8:0] + 1. Multiplex ratio (MUX ratio) from 16 MUX to 296MUX.

GD: Selects the 1st output Gate

This bit is made to match the GATE layout connection on the panel. It defines the first scanning line.

SM: Change scanning order of gate driver.

When SM is set to 0, left and right interlaced is performed.

When SM is set to 1, no splitting odd / even of the GATE signal is performed,

Output pin assignment sequence is shown as below (for 296 MUX ratio):

| | SM=0 | SM=0 | SM=1 | SM=1 |
|--------|--------|--------|--------|--------|
| Driver | GD=0 | GD=1 | GD=0 | GD=1 |
| G0 | ROW0 | ROW1 | ROW0 | ROW148 |
| G1 | ROW1 | ROW0 | ROW148 | ROW0 |
| G2 | ROW2 | ROW3 | ROW1 | ROW149 |
| G3 | ROW3 | ROW2 | ROW149 | ROW1 |
| : | : | : | : | : |
| G146 | ROW146 | ROW147 | ROW73 | ROW222 |
| G147 | ROW147 | ROW146 | ROW222 | ROW73 |
| G148 | ROW148 | ROW149 | ROW74 | ROW223 |
| G149 | ROW149 | ROW148 | ROW223 | ROW74 |
| : | : | : | : | : |
| G292 | ROW292 | ROW293 | ROW146 | ROW294 |
| G293 | ROW293 | ROW292 | ROW294 | ROW146 |
| G294 | ROW294 | ROW295 | ROW147 | ROW295 |
| G295 | ROW295 | ROW294 | ROW295 | ROW147 |

See "Scan Mode Setting" on next page.

TB: Change scanning direction of gate driver.

This bit defines the scanning direction of the gate for flexible layout of signals in module either from up to down (TB = 0) or from bottom to up (TB = 1).

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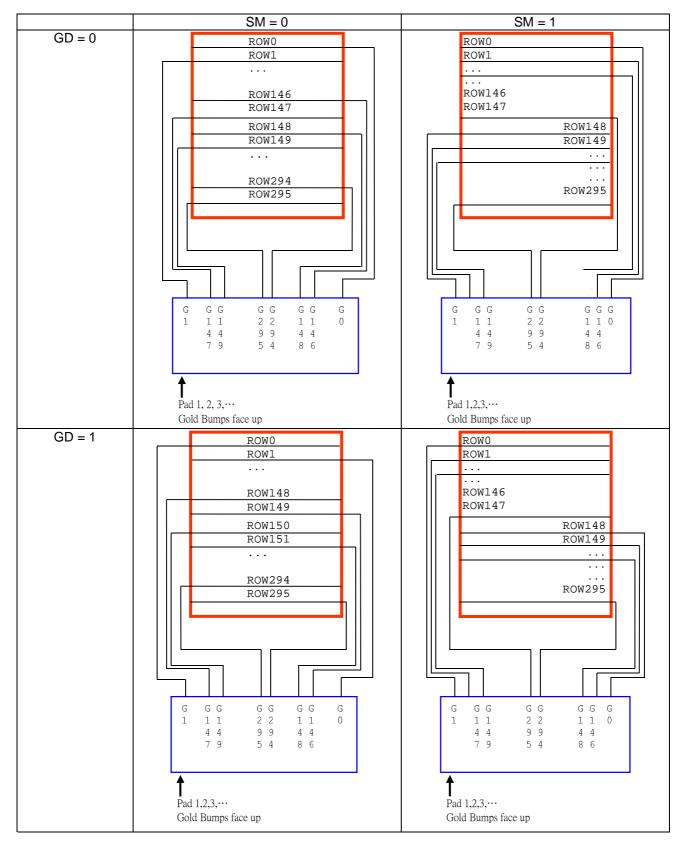


Figure 8-1: Output pin assignment on different Scan Mode Setting

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8.2 Gate Scan Start Position (0Fh)

| - | | | | | | | | | |
|-----|-----|------|------|------|------|------|------|------|------|
| R/W | DC | IB7 | IB6 | IB5 | IB4 | IB3 | IB2 | IB1 | IB0 |
| W | 1 | SCN7 | SCN6 | SCN5 | SCN4 | SCN3 | SCN2 | SCN1 | SCN0 |
| POR | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| W | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | SCN8 |
| PC | POR | | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

This command is to set Gate Start Position for determining the starting gate of display RAM by selecting a value from 0 to 295. Figure 8-2 shows an example using this command of this command when MUX ratio= 295 and MUX ratio= 148. "ROW" means the graphic display data RAM row.

Figure 8-2: Example of Set Display Start Line with no Remapping

| Г | MUX ratio (01h) = 127h | MLIV ratio (01b) - 002b | MUX ratio (01h) = 095h |
|--------------------|---------------------------|--|---------------------------|
| GATE Pin | Gate Start Position (0Fh) | MUX ratio (01h) = 093h Gate Start Position (0Fh) | Gate Start Position (0Fh) |
| GATEPIN | = 000h | = 000h | = 04Ah |
| G0 | = 000f1 ROW0 | = 000fi ROW0 | = 04An |
| G0 G1 | ROW1 | ROW1 | - |
| G2 | ROW1 | ROW1 ROW2 | - |
| | | | - |
| G3 | ROW3 | ROW3 | - |
| - | : | : | ; |
| : | : | : | ; |
| G72 | <u> </u> | : | - |
| G73 | : | : | - |
| G74 | : | : | ROW74 |
| G75 | : | ÷ | ROW75 |
| : | <u> </u> | : | : |
| : | <u> </u> | : | : |
| G146 | ROW146 | ROW146 | : |
| G147 | ROW147 | ROW147 | : |
| G148 | ROW148 | - | : |
| G149 | ROW149 | - | : |
| : | : | : | : |
| | : | : | : |
| G220 | : | : | : |
| G221 | : | : | : |
| G222 | : | : | ROW222 |
| G223 | : | : | ROW223 |
| | : | : | : |
| : | : | ÷ | : |
| G292 | ROW292 | - | - |
| G293 | ROW293 | - | - |
| G294 | ROW294 | - | - |
| G295 | ROW295 | - | - |
| Display Example | SOLOMON | | SOLOMON |

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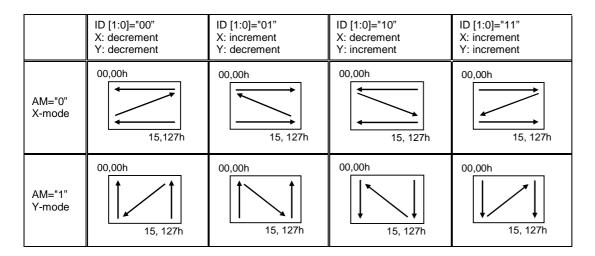
8.3 Data Entry Mode Setting (11h)

This command has multiple configurations and each bit setting is described as follows:

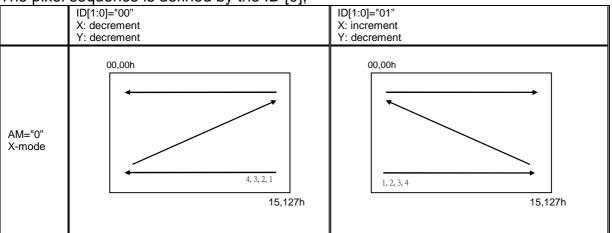
| | R/W | DC | IB7 | IB6 | IB5 | IB4 | IB3 | IB2 | IB1 | IB0 |
|---|-----|----|-----|-----|-----|-----|-----|-----|-----|-----|
| | W | 1 | | | | | | AM | ID1 | ID0 |
| Ī | POR | | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 |

ID[1:0]: The address counter is automatically incremented by 1, after data is written to the RAM when ID[1:0] = "01". The address counter is automatically decremented by 1, after data is written to the RAM when ID[1:0] = "00". The setting of incrementing or decrementing of the address counter can be made independently in each upper and lower bit of the address. The direction of the address when data is written to the RAM is set by AM bits.

AM: Set the direction in which the address counter is updated automatically after data are written to the RAM. When AM = "0", the address counter is updated in the X direction. When AM = "1", the address counter is updated in the Y direction. When window addresses are selected, data are written to the RAM area specified by the window addresses in the manner specified with ID[1:0] and AM bits.







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8.4 Set RAM X - Address Start / End Position (44h)

| R/W | DC | IB7 | IB6 | IB5 | IB4 | IB3 | IB2 | IB1 | IB0 |
|-----|-----|-----|-----|-----|------|------|------|------|------|
| W | 1 | | | | XSA4 | XSA3 | XSA2 | XSA1 | XSA0 |
| POR | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| w | 1 | | | | XEA4 | XEA3 | XEA2 | XEA1 | XEA0 |
| PC | POR | | 0 | 0 | 1 | 0 | 1 | 0 | 1 |

XSA[4:0]/XEA[4:0]: Specify the start/end positions of the window address in the X direction by 8 times address unit. Data is written to the RAM within the area determined by the addresses specified by XSA [4:0] and XEA [4:0]. These addresses must be set before the RAM write.

It allows on XEA [4:0] \leq XSA [4:0]. The settings follow the condition on 00h \leq XSA [4:0], XEA [4:0] \leq 15h. The windows is followed by the control setting of Data Entry Setting (R11h)

8.5 Set RAM Y - Address Start / End Position (45h)

| R/W | DC | IB7 | IB6 | IB5 | IB4 | IB3 | IB2 | IB1 | IB0 |
|-----|-----|------|------|------|------|------|------|------|------|
| W | 1 | YSA7 | YSA6 | YSA5 | YSA4 | YSA3 | YSA2 | YSA1 | YSA0 |
| PC | POR | | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| W | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | YSA8 |
| PC |)R | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| W | 1 | YEA7 | YEA6 | YEA5 | YEA4 | YEA3 | YEA2 | YEA1 | YEA0 |
| PC | POR | | 0 | 1 | 0 | 0 | 1 | 1 | 1 |
| W | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | YEA8 |
| POR | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |

YSA[8:0]/YEA[8:0]: Specify the start/end positions of the window address in the Y direction by an address unit. Data is written to the RAM within the area determined by the addresses specified by YSA [8:0] and YEA [8:0]. These addresses must be set before the RAM write.

It allows YEA [8:0] \leq YSA [8:0]. The settings follow the condition on 00h \leq YSA [8:0], YEA [8:0] \leq 127h. The windows is followed by the control setting of Data Entry Setting (R11h)

8.6 Set RAM Address Counter (4Eh-4Fh)

| Reg# | R/W | DC | IB7 | IB6 | IB5 | IB4 | IB3 | IB2 | IB1 | IB0 |
|------|-----|----|------|------|------|------|------|------|------|------|
| 4Eh | W | 1 | | | | XAD4 | XAD3 | XAD2 | XAD1 | XAD0 |
| | PC |)R | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | W | 1 | YAD7 | YAD6 | YAD5 | YAD4 | YAD3 | YAD2 | YAD1 | YAD0 |
| | POR | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 4Fh | W | 1 | | | | | | | | YAD8 |
| | POR | | | | | | | | | 0 |

XAD[4:0]: Make initial settings for the RAM X address in the address counter (AC). **YAD[8:0]:** Make initial settings for the RAM Y address in the address counter (AC).

After RAM data is written, the address counter is automatically updated according to the settings with AM, ID bits and setting for a new RAM address is not required in the address counter. Therefore, data is written consecutively without setting an address. The address counter is not automatically updated when data is read out from the RAM. RAM address setting cannot be made during the standby mode. The address setting should be made within the area designated with window addresses which is controlled by the Data Entry Setting (R11h) {AM, ID[1:0]}; RAM Address XStart / XEnd Position (R44h) and RAM Address Ystart / Yend Position (R45h). Otherwise undesirable image will be displayed on the Panel.

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9 Operation Flow and Code Sequence

9.1 General operation flow to drive display panel

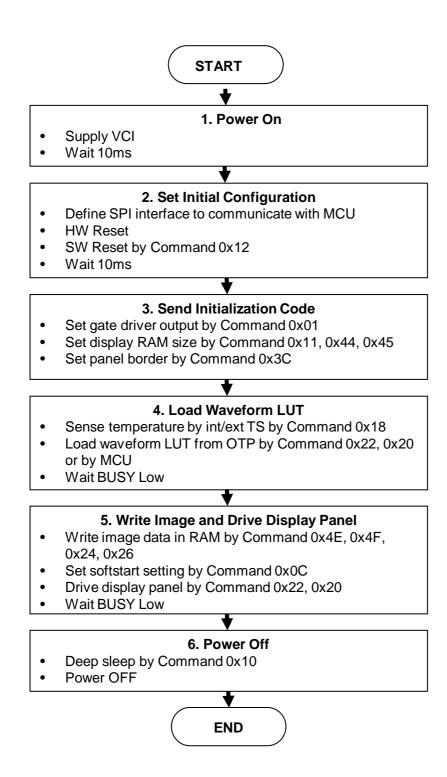


Figure 9-1: Operation flow to drive display panel

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10 Absolute Maximum Rating

Table 10-1: Maximum Ratings

| Symbol | Parameter | Rating | Unit |
|------------------|-----------------------------|--------------------------------|------|
| Vcı | Logic supply voltage | -0.5 to +6.0 | V |
| VIN | Logic Input voltage | -0.5 to V _{DDIO} +0.5 | V |
| Vouт | Logic Output voltage | -0.5 to V _{DDIO} +0.5 | V |
| Topr | Operation temperature range | -40 to +85 | °C |
| T _{STG} | Storage temperature range | -65 to +150 | °C |

Maximum ratings are those values beyond which damages to the device may occur. Functional operation should be restricted to the limits in the Electrical Characteristics tables or Pin Description section

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit. For proper operation it is recommended that V_{CI} be constrained to the range $V_{SS} < V_{CI}$. Reliability of operation is enhanced if unused input is connected to an appropriate logic voltage level (e.g., either V_{SS} or V_{DDIO}). Unused outputs must be left open. This device may be light sensitive. Caution should be taken to avoid exposure of this device to any light source during normal operation. This device is not radiation protected.

11 Electrical Characteristics

The following specifications apply for: VSS=0V, VCI=3.0V, VDD=1.8V, T_{OPR}=25°C.

Table 11-1: DC Characteristics

| Symbol | Parameter | Applicable pin | Test Condition | Min. | Тур. | Max. | Unit |
|------------------------|----------------------------------|------------------------------------|-------------------|---------------------------------------|---------------------|---|------|
| Vcı | VCI operation voltage | VCI | | 2.2 | 3.0 | 3.7 | V |
| V_{DD} | VDD operation voltage | VDD | | 1.7 | 1.8 | 1.9 | V |
| V _{COM_DC} | VCOM_DC output voltage | VCOM | | -3.0 | | -0.2 | V |
| dV _{сом_дс} | VCOM_DC output voltage deviation | VCOM | | -200 | | 200 | mV |
| V _{СОМ_АС} | VCOM_AC output voltage | VCOM | | V _{SL} + V _{COM_DC} | V _{СОМ_DС} | V _{SH1} + V _{COM_DC} | V |
| VGATE | Gate output voltage | G0~G295 | | -20 | | +20 | V |
| V _{GATE(p-p)} | Gate output peak to peak voltage | G0~G295 | | | | 40 | V |
| V _{SH1} | Positive Source output voltage | VSH1 | | +2.4 | +15 | +17 | V |
| dV _{SH1} | VSH1 output voltage | VSH1 | From 2.4V to 8.8V | -100 | | 100 | mV |
| | deviation | | From 9.0V to 17V | -200 | | 200 | mV |
| V _{SH2} | Positive Source output voltage | VSH2 | | +2.4 | +5 | +17 | V |
| dV _{SH2} | VSH2 output voltage | VSH2 | From 2.4V to 8.8V | -100 | | 100 | mV |
| | deviation | | From 9.0V to 17V | -200 | | 200 | mV |
| V _{SL} | Negative Source output voltage | VSL | | -17 | -15 | -9 | V |
| dV _{SL} | VSL output voltage deviation | VSL | | -200 | | 200 | mV |
| V _{IH} | High level input voltage | SDA, SCL, CS#, D/C#, RES#, BS1, | | 0.8V _{DDIO} | | | V |
| V _{IL} | Low level input voltage | M/S#, CL | | | | 0.2V _{DDIO} | V |
| Vон | High level output voltage | SDA, BUSY, CL | IOH = -100uA | 0.9V _{DDIO} | | | V |
| V_{OL} | Low level output voltage | | IOL = 100uA | | | $0.1V_{\text{DDIO}}$ | V |
| V_{PP} | OTP Program voltage | VPP | | 7.25 | 7.5 | 7.75 | V |

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| Symbol | Parameter | Applicable pin | Test Condition | Min. | Тур. | Max. | Unit |
|------------------|-------------------------------|----------------|--|-------|------|-------|------|
| Islp_VCI | Sleep mode current | VCI | DC/DC offNo clockNo output loadMCU interface accessRAM data access | | 20 | 35 | uA |
| Idslp_VCI1 | Current of deep sleep mode 1 | VCI | - DC/DC off - No clock - No output load - No MCU interface access - Retain RAM data but cannot access the RAM | | 1 | 3 | uA |
| Idslp_VCI2 | Current of deep sleep mode 2 | VCI | - DC/DC off - No clock - No output load - No MCU interface access - Cannot retain RAM data | | 0.7 | 3 | uA |
| lopr_VCI | Operating Mode current | VCI | VCI=3.0V | | 1000 | | uA |
| V _{GH} | Operating Mode Output Voltage | VGH | Enable Clock and Analog by Master Activation Command | 19.5 | 20 | 20.5 | V |
| V _{SH1} | | VSH1 | VGH=20V VGL=-VGH | 14.8 | 15 | 15.2 | V |
| V _{SH2} | | VSH2 | VSH1=15V VSH2=5V | 4.9 | 5 | 5.1 | V |
| V _{SL} | | VSL | VSL=-15V VCOM = -2V | -15.2 | -15 | -14.8 | V |
| V _{СОМ} | | VCOM | No waveform transitions. No loading. No RAM read/write No OTP read /write | -2.2 | -2 | -1.8 | V |

Table 11-2: Regulators Characteristics

| Symbol | Parameter | Test Condition | Applicable pin | Min. | Тур. | Max. | Unit |
|--------|--------------|----------------|----------------|------|------|------|------|
| IVSH | VSH1 current | VSH1 = +15V | VSH1 | | | 800 | uA |
| IVSH1 | VSH2 current | VSH2 = +5V | VSH2 | | | 800 | uA |
| IVSL | VSL current | VSL = -15V | VSL | | | 800 | uA |
| IVCOM | VCOM current | VCOM = -2V | VCOM | | | 100 | uA |

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12 AC Characteristics

12.1 Serial Peripheral Interface

The following specifications apply for: VDDIO - VSS = 2.2V to 3.7V, T_{OPR} = 25°C, CL=20pF

Table 12-1: Serial Peripheral Interface Timing Characteristics

Write mode

| Symbol | Parameter | Min | Тур | Max | Unit |
|--------------------|--|-----|-----|-----|------|
| fscL | SCL frequency (Write Mode) | | | 20 | MHz |
| tcssu | Time CS# has to be low before the first rising edge of SCLK | 60 | | | ns |
| tcshld | Time CS# has to remain low after the last falling edge of SCLK | 65 | | | ns |
| tcsнigh | Time CS# has to remain high between two transfers | 100 | | | ns |
| tsclhigh | Part of the clock period where SCL has to remain high | 25 | | | ns |
| tscllow | Part of the clock period where SCL has to remain low | 25 | | | ns |
| tsisu | Time SI (SDA Write Mode) has to be stable before the next rising edge of SCL | 10 | | | ns |
| t _{SIHLD} | Time SI (SDA Write Mode) has to remain stable after the rising edge of SCL | 40 | | | ns |

Read mode

| Symbol | Parameter | Min | Тур | Max | Unit |
|--------------------|--|-----|-----|-----|------|
| f _{SCL} | SCL frequency (Read Mode) | | | 2.5 | MHz |
| tcssu | Time CS# has to be low before the first rising edge of SCLK | 100 | | | ns |
| tcshld | Time CS# has to remain low after the last falling edge of SCLK | 50 | | | ns |
| tcsнigh | Time CS# has to remain high between two transfers | 250 | | | ns |
| tsclhigh | Part of the clock period where SCL has to remain high | 180 | | | ns |
| tscllow | Part of the clock period where SCL has to remain low | 180 | | | ns |
| tsosu | Time SO(SDA Read Mode) will be stable before the next rising edge of SCL | | 50 | | ns |
| t _{SOHLD} | Time SO (SDA Read Mode) will remain stable after the falling edge of SCL | | 0 | | ns |

Note: All timings are based on 20% to 80% of VDDIO-VSS

CS#

CKPFR

CKPFR

CKPFR

CKPFR

CKPFR

CKPFR

CKPFR

CKPFR

CKSHIGH

CCSHIGH

CCSHI

Figure 12-1: SPI timing diagram

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13 Application Circuit

ı | | C2 GDR VSH2 TSCL TSCL TSDA CONNECTION BS1 BUSY RES# EXTERNAL TEMP SENSOR D/C# BS1 SCI BUSY RES# SDA CONNECTION D/C# MCU VSS SDA VPP VSH1 20 VCI VSS VDD CO VPP VSH1 C1 VGH C5 VSL VGL VCOM C7 C8

Figure 13-1: Schematic of SSD1680 application circuit

Table 13-1: Component list for SSD1680 application circuit

| Part Name | Value | Requirements/Reference Part | |
|-----------|--|--|--|
| C0-C1 | 1uF | X5R/X7R; Voltage Rating : 6V or 25V | |
| C2-C7 | C2-C7 1uF 0402/0603/0805; X5R/X7R; Voltage | | |
| C8 | 0.47uF, 1uF | 0603/0805; X7R; Voltage Rating : 25V Note: Effective capacitance > 0.25uF @ 18V DC bias | |
| R1 | 2.2 ohm | 0402, 0603, 0805; 1% variation, ≥ 0.05W | |
| D1-D3 | MBR0530 1) Reverse DC voltage ≥ 30V 2) Io ≥ 500mA 3) Forward voltage ≤ 430mV | | |
| Q1 | NMOS | Si1304BDL/NX3008NBK 1) Drain-Source breakdown voltage ≥ 30V 2) Vgs(th) = 0.9V (Typ), 1.3V (Max) 3) Rds on ≤ 2.1Ω @ Vgs = 2.5V | |
| L1 | 47uH | CDRH2D18 / LDNP-470NC lo= 500mA (Max) | |
| U1 | 0.5mm ZIF socket | 24pins, 0.5mm pitch | |

Remarks:

- 1) The recommended component value and reference part in Table 13-1 is subject to change depending on panel loading.
- 2) Customer is required to review if the selected component value and part is suitable for their application.

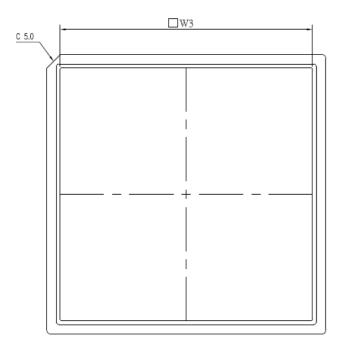
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14 Package Information

14.1 Die Tray Dimensions for SSD1680Z

Figure 14-1 : SSD1680Z die tray information (unit: mm)





| Symbol | Spec(mm) |
|--------|--------------------|
| W1 | 101.60±0.10 |
| W2 | 91.55±0.10 |
| W3 | 91.85±0.10 |
| Н | 4.55±0.10 |
| Dx | 11.25±0.10 |
| TPx | 79.10±0.10 |
| Dy | 7.60±0.10 |
| TPy | 86.40±0.10 |
| Px | 11.30±0.05 |
| Ру | 2.70±0.05 |
| Х | 9.661±0.05 |
| Υ | 1.125±0.05 |
| Z | 0.40±0.05 |
| N | 264(pocket number) |

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14.2 Die Tray Dimensions for SSD1680Z8

 $\square W$ □W2 C 5.0±0.5 7xPx=TPx D40-380X44-16(264) À Cav. No.(1 & 2) 8X33=264 SECTION A-A \square W3 Spec (mm) Symbol 7xPx=TPxW1 101.60±0.10 W2 91.55±0.10 Ď W3 91.75±0.10 Н 4.55±0.10 Px 11.20±0.05 Ру 2.70±0.05 11.60±0.05 Dx 78.40±0.10 TPx Dy 7.60±0.05 TPy 86.40±0.10 Χ 9.661±0.05 1.125±0.05 Y Ζ 0.40 ± 0.05 X1 9.661±0.05 Y1 1.125±0.05 Ζ1 0.35±0.05 Px. 8x33=264 (pocket number)

Figure 14-2 : SSD1680Z8 die tray information (unit: mm)

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